

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

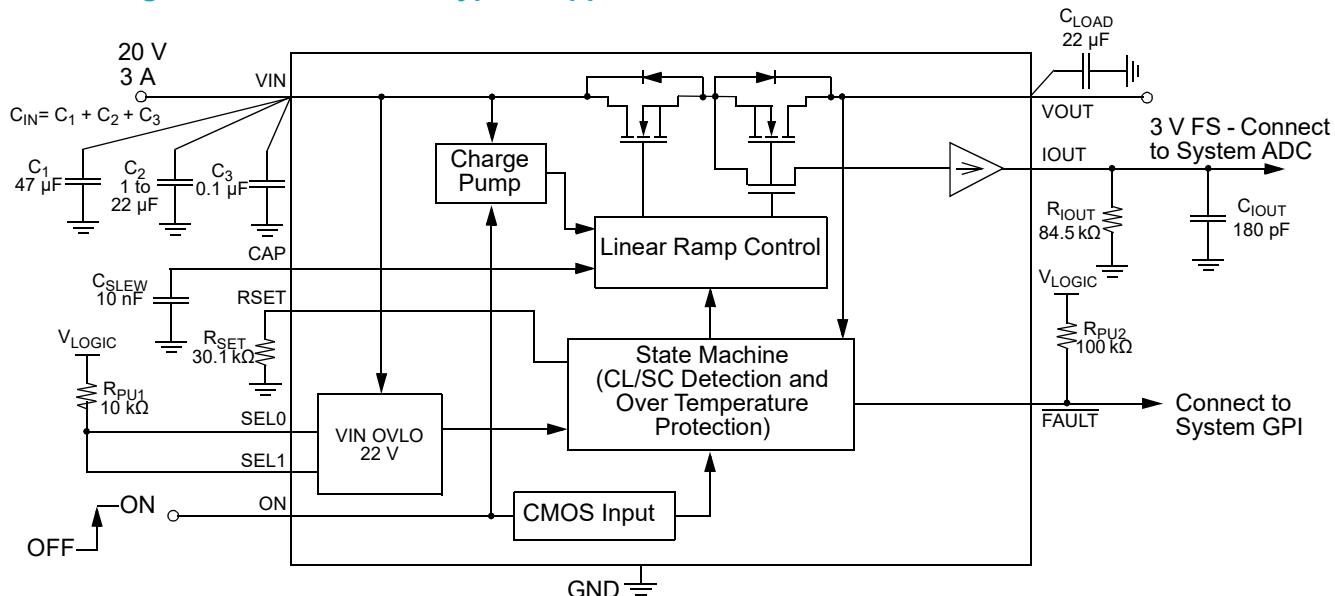
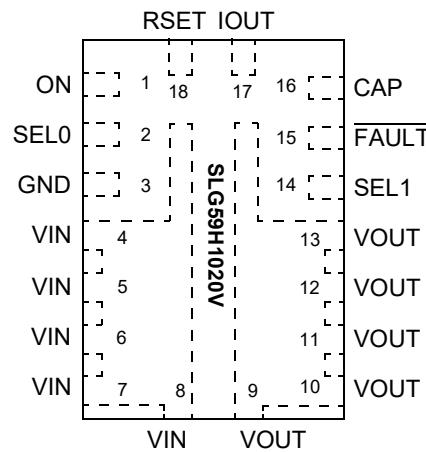
General Description

The SLG59H1020V is a high-performance, self-powered 50 mΩ NMOS load switch with back-to-back reverse-current blocking designed for all 4.5 V to 20 V power rails up to 3 A. Using a proprietary MOSFET design, the SLG59H1020V achieves a stable 50 mΩ RDS_{ON} across a wide input voltage range. In combining novel FET design and copper pillar interconnects, the SLG59H1020V package also exhibits a low thermal resistance for high-current operation.

Designed to operate over a -40°C to 85°C range, the SLG59H1020V is available in a low thermal resistance, RoHS-compliant, 1.6 x 3.0 mm STQFN package.

Features

- Wide Operating Input Voltage: 4.5 V to 20 V
- Maximum Continuous Current: 3 A
- Automatic nFET SOA Protection
 - 5 W SOA Protection Threshold
- Back-to-Back FET Reverse Current Blocking, when OFF
- Internal nFET Power Limiting
- High-performance MOSFET Switch
 - Low RDS_{ON}: 50 mΩ at V_{IN} = 20 V
 - Low ΔRDS_{ON}/ΔV_{IN}: < 0.05 mΩ/V
 - Low ΔRDS_{ON}/ΔT: < 0.06 mΩ/°C
- 4-Level, Pin-selectable V_{IN} Overvoltage Lockout
- Capacitor-adjustable Inrush Current Control
- Two stage Current Limit Protection:
 - Resistor-adjustable Active Current Limit
 - Internal Short-circuit Current limit
- Open Drain FAULT Signaling
- MOSFET Current Analog Output Monitor: 10 μA/A
 - Pb-Free / Halogen-Free / RoHS Compliant Packaging

Block Diagram and a 20 V / 3 A Typical Application Circuit**Pin Configuration****18-pin STQFN**

1.6 x 3.0 mm, 0.40mm pitch
(Top View)

Applications

- Power-Rail Switching
- Multifunction Printers
- Large-format Copiers
- Telecommunications Equipment
- High-performance Computing
- 4.5 V and 20 V Point-of-Load Power Distribution
- Motor Drives

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Pin Description

Pin #	Pin Name	Type	Pin Description
1	ON	Input	A low-to-high transition on this pin initiates the operation of the SLG59H1020V's state machine. ON is an asserted HIGH, level-sensitive CMOS input with ON_V _{IL} < 0.3 V and ON_V _{IH} > 0.9 V. As the ON pin input circuit does not have an internal pull-down resistor, connect this pin to a general-purpose output (GPO) of a microcontroller, an application processor, or a system controller – do not allow this pin to be open-circuited.
2	SEL0	Input	As level-sensitive, CMOS inputs with V _{IL} < 0.3 V and V _{IH} > 1.65 V, the SEL0 (LSB) and the SEL1 (MSB) pins select one of four V _{IN} overvoltage lockout thresholds. Please see the Applications Section for additional information and the Electrical Characteristics table for the V _{IN} overvoltage thresholds. A logic LOW on either pin is achieved by connecting the pin of interest to GND; a logic HIGH on either pin is achieved by connecting a 10 kΩ external resistor from the pin in question to the system's local logic supply.
3	GND	GND	Pin 3 is the main ground connection for the SLG59H1020V's internal charge pump, its gate driver and current-limit circuits as well as its internal state machine. Therefore, use a short, stout connection from Pin 3 to the system's analog or power plane.
4-8	VIN	MOSFET	VIN supplies the power for the operation of the SLG59H1020V, its internal control circuitry, and the drain terminal of the back-to-back, reverse-blocking nFET load switch. With 5 pins fused together at VIN, connect a 47 μF (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VIN should be rated at 50 V or higher.
9-13	VOUT	MOSFET	Drain terminal of n-channel MOSFET (5 pins fused for VOUT). Connect a 22 μF (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VOUT should be rated at 50 V or higher.
14	SEL1	Input	Please see SEL0 Pin Description above
15	FAULT	Output	An open drain output, FAULT is asserted within TFAULT _{LOW} when a V _{IN} overvoltage, a current-limit, or an over-temperature condition is detected. FAULT is deasserted within TFAULT _{HIGH} when the fault condition is removed. Connect an 100 kΩ external resistor from the FAULT pin to local system logic supply.
16	CAP	Output	A low-ESR, stable dielectric, ceramic surface-mount capacitor connected from CAP pin to GND sets the V _{OUT} slew rate and overall turn-on time of the SLG59H1020V. For best performance, the range for C _{SLEW} values are 10 nF ≤ C _{SLEW} ≤ 20 nF – please see typical characteristics for additional information. Capacitors used at the CAP pin should be rated at 10 V or higher. Please consult Applications Section on how to select C _{SLEW} based on V _{OUT} slew rate and loading conditions.
17	IOUT	Output	IOUT is the SLG59H1020V's power MOSFET load current monitor output. As an analog current output, this signal when applied to a ground-reference resistor generates a voltage proportional to the current through the n-channel MOSFET. The I _{OUT} transfer characteristic is typically 10 μA/A with a voltage compliance range of 0.5 V ≤ V _{IOUT} ≤ 4 V. Optimal I _{OUT} linearity is exhibited for 0.5 A ≤ I _{DS} ≤ 3 A. In addition, it is recommended to bypass the IOUT pin to GND with a 0.18 nF capacitor.
18	RSET	Input	A 1%-tolerance, metal-film resistor between 30 kΩ and 91 kΩ sets the SLG59H1020V's active current limit. A 91 kΩ resistor sets the SLG59H1020V's active current limit to 1 A and a 30 kΩ resistor sets the active current limit to 3 A.

Ordering Information

Part Number	Type	Production Flow
SLG59H1020V	STQFN 18L FC	Industrial, -40 °C to 85 °C

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
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Part Number	Type	Production Flow
SLG59H1020VTR	STQFN 18L FC (Tape and Reel)	Industrial, -40 °C to 85 °C

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
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Absolute Maximum Ratings

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V _{IN} to GND	Load Switch Input Voltage to GND	Continuous	-0.3	--	30	V
		Maximum pulsed V _{IN} , pulse width < 0.1 s	--	--	32	V
V _{OUT} to GND	Load Switch Output Voltage to GND		-0.3	--	V _{IN}	V
ON, SEL[1,0], CAP, RSET, I _{OUT} , and FAULT to GND	ON, SEL[1,0], CAP, RSET, I _{OUT} , and FAULT Pin Voltages to GND		-0.3	--	7	V
T _S	Storage Temperature		-65	--	150	°C
ESD _{HBM}	ESD Protection	Human Body Model	2000	--	--	V
ESD _{CDM}	ESD Protection	Charged Device Model	500	--	--	V
MSL	Moisture Sensitivity Level		1			
θ _{JA}	Thermal Resistance	1.6 x 3.0 mm 18L STQFN; Determined with the device mounted onto a 1 in ² , 1 oz. copper pad of FR-4 material	--	40	--	°C/W
T _{J,MAX}	Maximum Junction Temperature		--	150	--	°C
MOSFET I _{DS} _{CONT}	Continuous Current from V _{IN} to V _{OUT}	T _J < 150 °C	--	--	3	A
MOSFET I _{DS} _{PEAK}	Peak Current from V _{IN} to V _{OUT}	Maximum pulsed switch current, pulse width < 1 ms	--	--	5	A
Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.						

Electrical Characteristics

4.5 V ≤ V_{IN} ≤ 20 V; C_{IN} = 47 µF, T_A = -40 °C to 85 °C, unless otherwise noted. Typical values are at T_A = 25 °C

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V _{IN}	Operating Input Voltage		4.5	--	20	V
V _{IN(OVLO)}	V _{IN} Overvoltage Lockout Threshold	V _{IN} ↑; SEL[1,0] = [0,0]	5.5	6.0	6.5	V
		V _{IN} ↑; SEL[1,0] = [0,1]	10.2	10.8	11.4	V
		V _{IN} ↑; SEL[1,0] = [1,0]	16.0	17.0	18.0	V
		V _{IN} ↑; SEL[1,0] = [1,1]	20.5	22.0	23.5	V
V _{IN(OVLOHYST)}	V _{IN} Overvoltage Lockout Hysteresis		--	2	--	%
I _Q	Quiescent Supply Current	ON = HIGH; I _{DS} = 0 A	--	0.5	0.6	mA
I _{SHDN}	OFF Mode Supply Current	ON = LOW; I _{DS} = 0 A	--	1	3	µA
R _{DS} _{ON}	ON Resistance	T _A = 25 °C; I _{DS} = 0.1 A	--	50	52	mΩ
		T _A = 85 °C; I _{DS} = 0.1 A	--	65	70	mΩ
MOSFET I _{DS}	Current from V _{IN} to V _{OUT}	Continuous	--	--	3	A
I _{REVERSE}	MOSFET Reverse-Leakage Current	V _{IN} = 0 V; V _{OUT} = 20 V; ON = 0 V	--	--	3	µA
I _{LIMIT}	Active Current Limit, I _{ACL}	V _{OUT} > 0.5 V; R _{SET} = 30.1 kΩ	3	3.2	3.4	A
	Short-circuit Current Limit, I _{SCL}	V _{OUT} < 0.5 V; V _{IN} = 4.5 V; R _{LOAD} = 0.5 Ω	--	0.8	--	A

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Electrical Characteristics (continued)

4.5 V ≤ V_{IN} ≤ 20 V; C_{IN} = 47 μF, T_A = -40 °C to 85 °C, unless otherwise noted. Typical values are at T_A = 25 °C

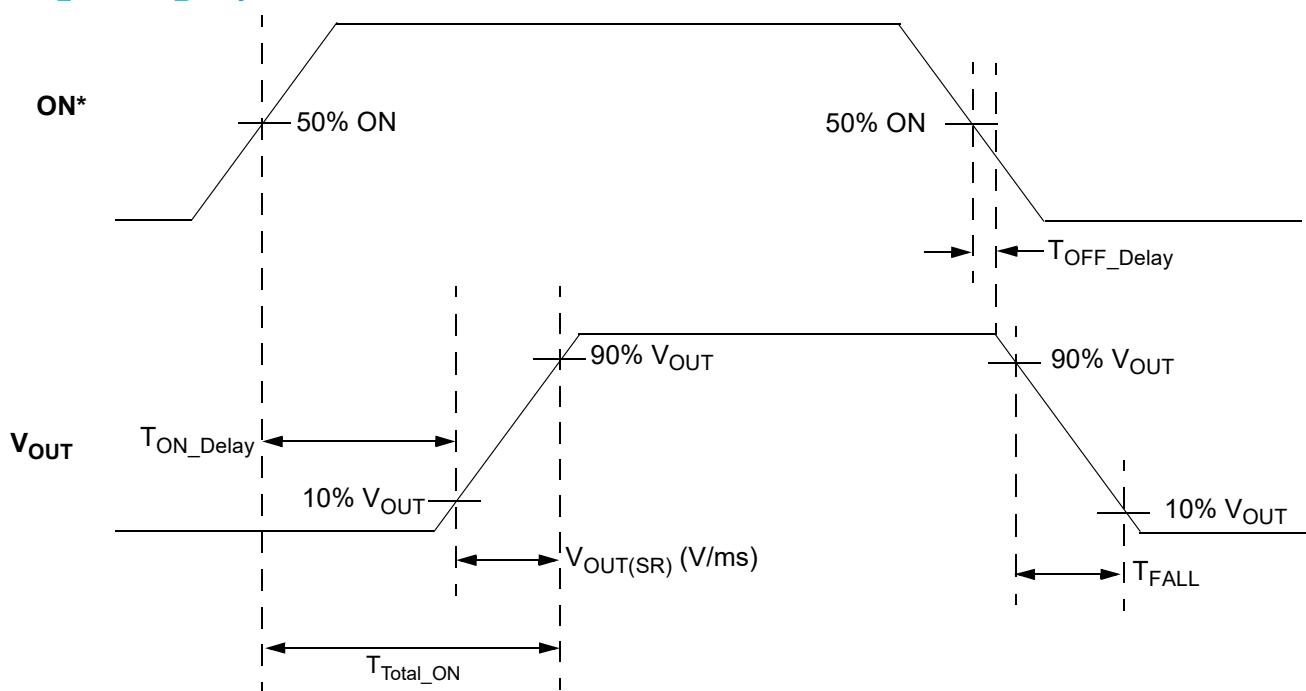
Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
T _{ACL}	Active Current Limit Response Time	R _{SET} = 51.6 kΩ	--	120	--	μs
I _{OUT}	MOSFET Current Analog Monitor Output	I _{DS} = 1 A	9.3	10	10.7	μA
		I _{DS} = 3 A	28.5	30	31.5	μA
T _{IOUT}	I _{OUT} Response Time to Change in Main MOSFET Current	C _{IOUT} = 180 pF; Step load 0 to 2.4 A; 0% to 90% I _{OUT}	--	45	--	μs
C _{LOAD}	Output Load Capacitance	C _{LOAD} connected from V _{OUT} to GND	--	22	--	μF
T _{ON_Delay}	ON Delay Time	50% ON to 10% V _{OUT} ↑; V _{IN} = 4.5 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF	--	0.3	0.5	ms
		50% ON to 10% V _{OUT} ↑; V _{IN} = 20 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF	--	0.7	1.2	ms
T _{Total_ON}	Total Turn ON Time	50% ON to 90% V _{OUT} ↑	Set by External C _{SLEW} ¹			ms
		50% ON to 90% V _{OUT} ↑; V _{IN} = 4.5 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF	--	1.5	2.1	ms
		50% ON to 90% V _{OUT} ↑; V _{IN} = 20 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF	--	6.5	8	ms
V _{OUT(SR)}	V _{OUT} Slew rate	50% ON to 90% V _{OUT} ↑	Set by External C _{SLEW} ¹			V/ms
		10% to 90% V _{OUT} ↑; V _{IN} = 4.5 V to 20 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF	2.7	3.2	3.9	V/ms
T _{OFF_Delay}	OFF Delay Time	50% ON to V _{OUT} Fall Start ↓; V _{IN} = 4.5 V to 20 V R _{LOAD} = 100 Ω, No C _{LOAD}	--	15	--	μs
T _{FALL}	V _{OUT} Fall Time	90% V _{OUT} to 10% V _{OUT} ↓; ON = HIGH-to-LOW; V _{IN} = 4.5 V to 20 V; R _{LOAD} = 100 Ω, No C _{LOAD}	10.4	12.7	14.3	μs
T _{FAULT_LOW}	FAULT Assertion Time	Abnormal Step Load Current event to FAULT↓; I _{ACL} = 1 A; V _{IN} = 20 V; R _{SET} = 91 kΩ; switch in 20 Ω load	--	80	--	μs
T _{FAULT_HIGH}	FAULT De-assertion Time	Delay to FAULT↑ after fault condition is removed; I _{ACL} = 1 A; V _{IN} = 20 V; R _{SET} = 91 kΩ; switch out 20 Ω load	--	180	--	μs
FAULT _{VOL}	FAULT Output Low Voltage	I _{FAULT} = 1 mA	--	0.2	--	V
ON _{V_{IH}}	ON Pin Input High Voltage		0.9	--	5	V
ON _{V_{IL}}	ON Pin Input Low Voltage		-0.3	0	0.3	V
SEL[1,0] _{V_{IH}}	SEL[1,0] pins Input High Voltage		1.65	--	4.5	V
SEL[1,0] _{V_{IL}}	SEL[1,0] pins Input Low Voltage		-0.3	--	0.3	V
I _{ON(Leakage)}	ON Pin Leakage Current	1 V ≤ ON ≤ 5 V or ON = GND	--	--	1	μA
THERM _{ON}	Thermal Protection Shutdown Threshold		--	125	--	°C
THERM _{OFF}	Thermal Protection Restart Threshold		--	100	--	°C

Notes:

1. Refer to typical Timing Parameter vs. C_{SLEW} performance charts for additional information when available.

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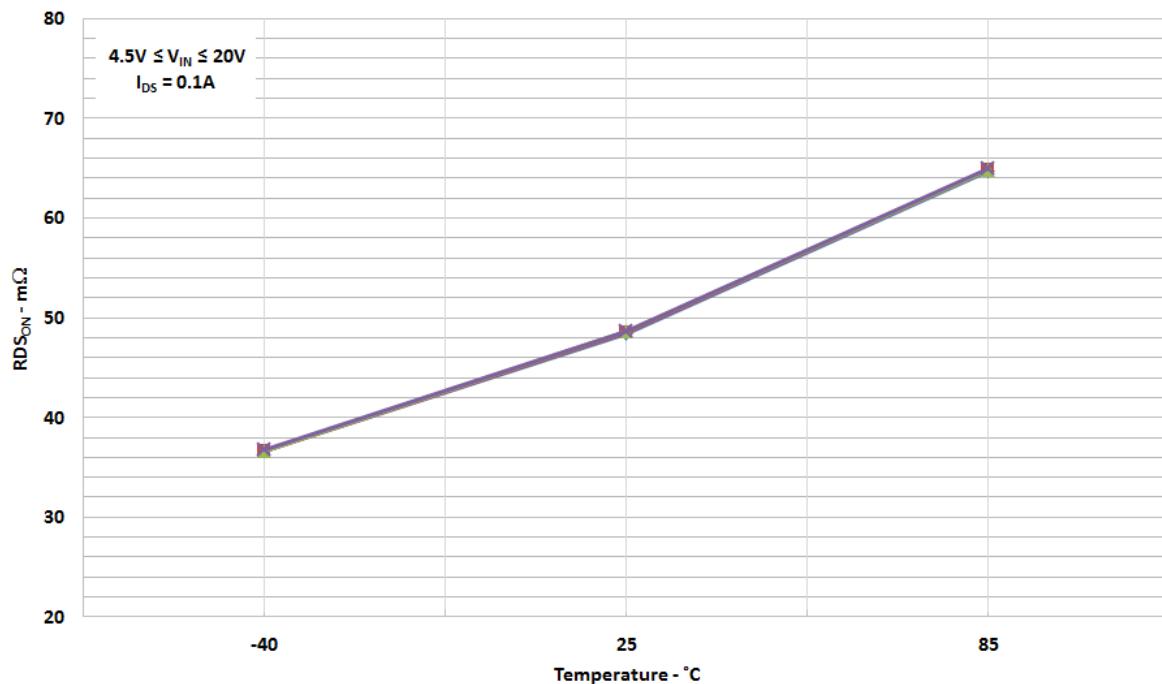
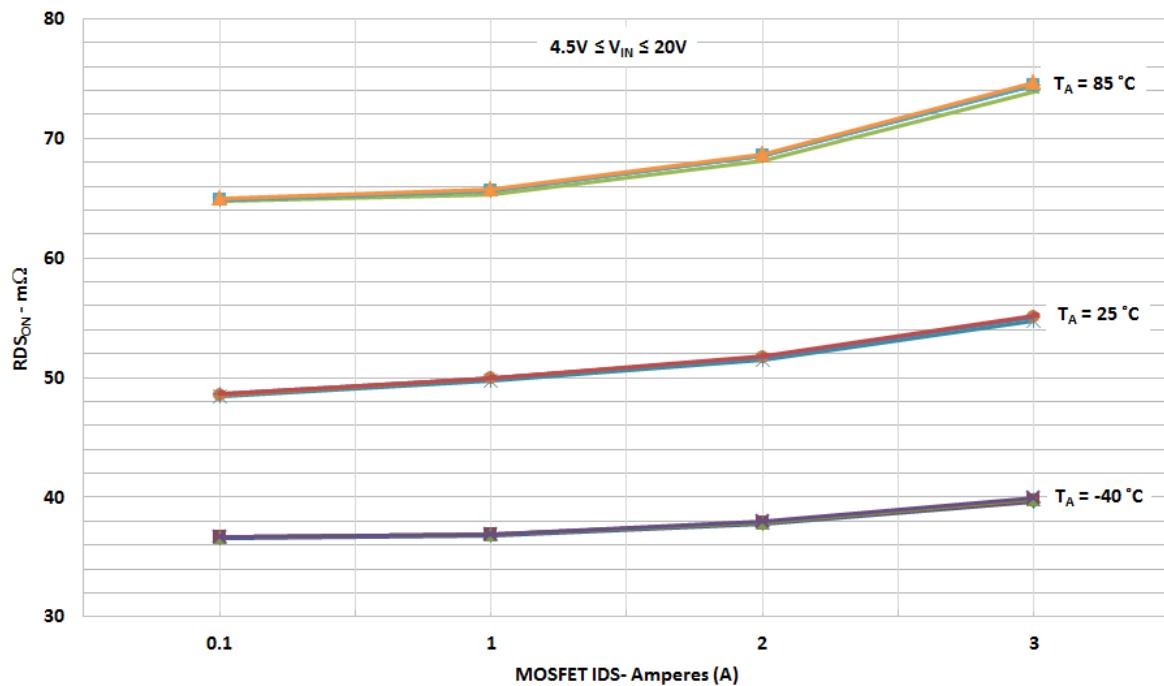
T_{Total_ON}, T_{ON_Delay} and Slew Rate Measurement



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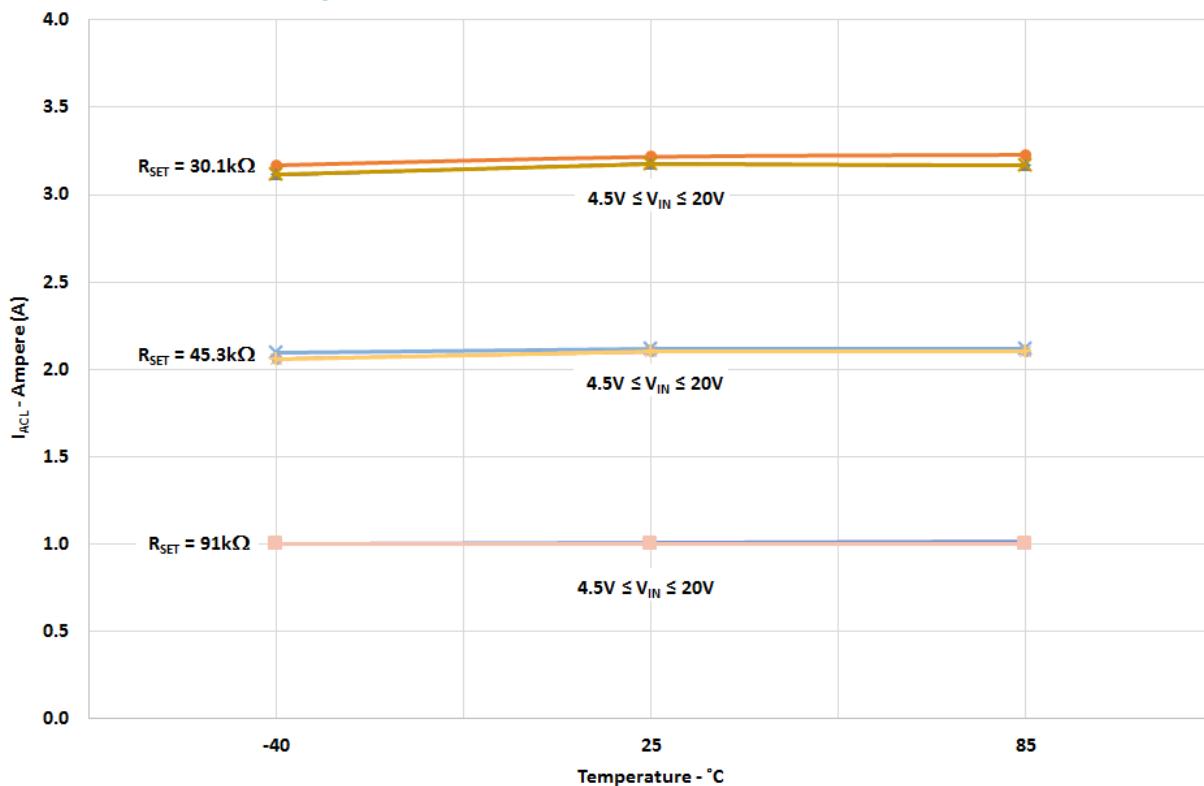
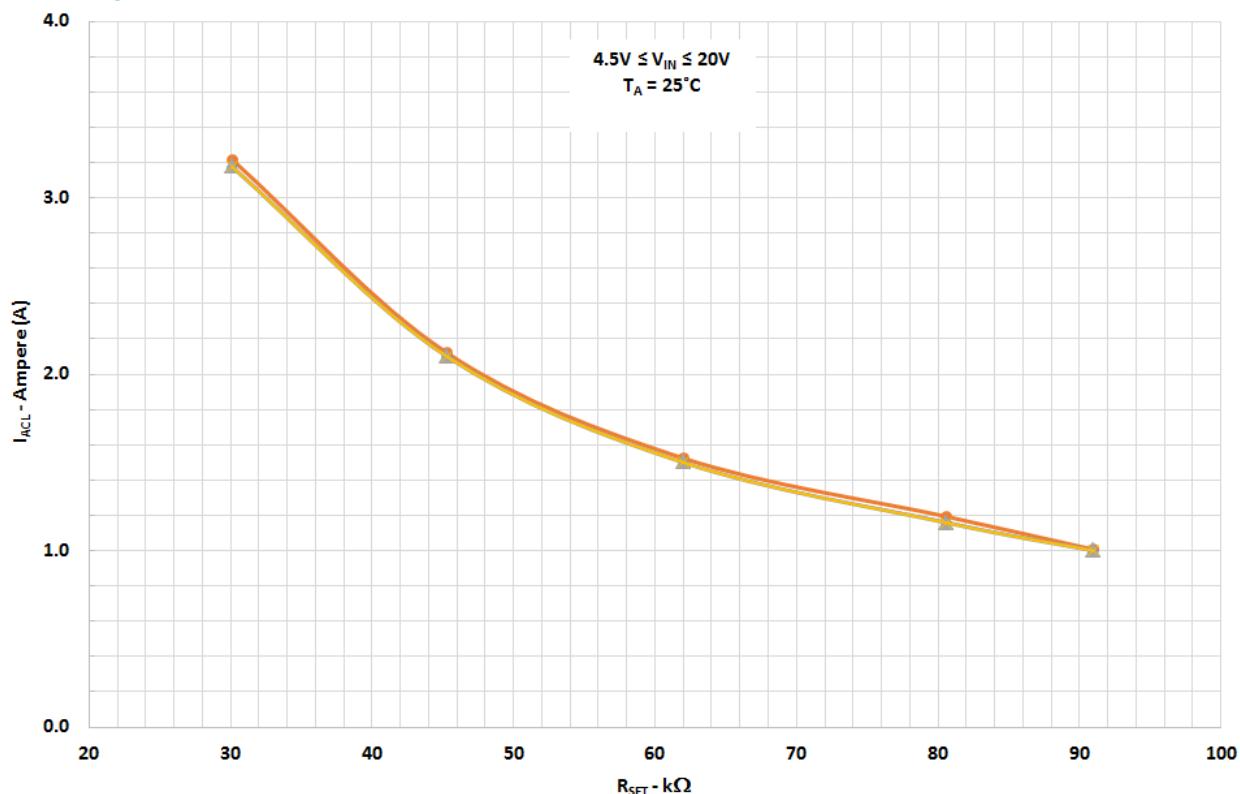
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Typical Performance Characteristics

RDS_{ON} vs. Temperature and V_{IN} RDS_{ON} vs. MOSFET IDS, V_{IN} , and Temperature

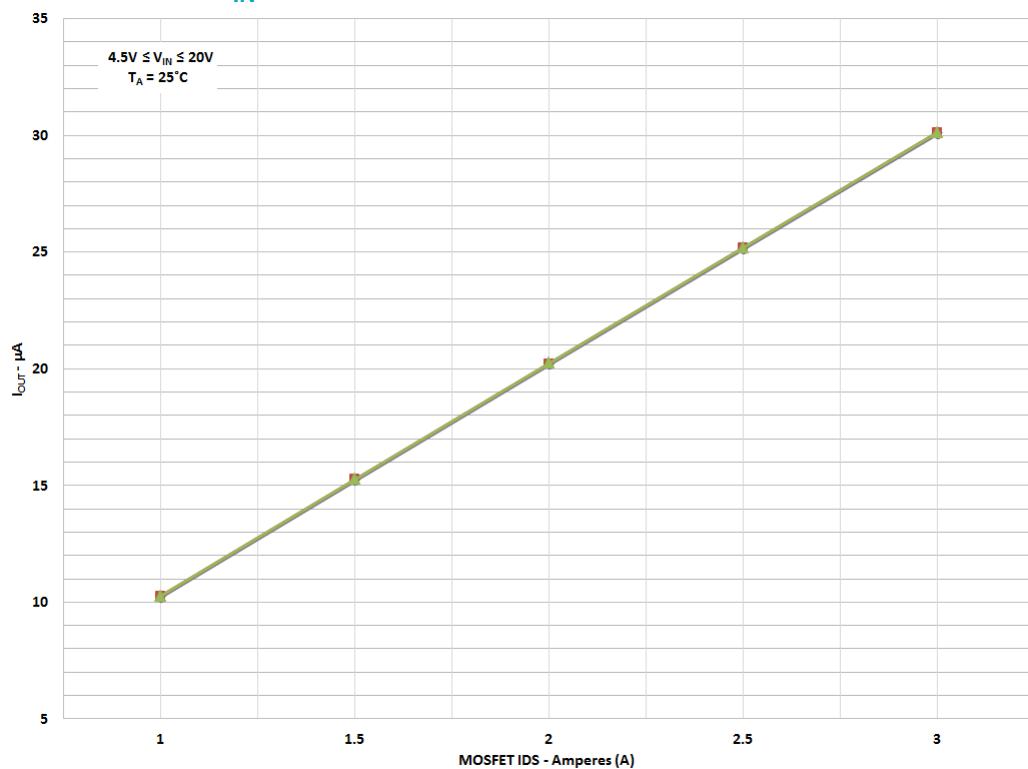
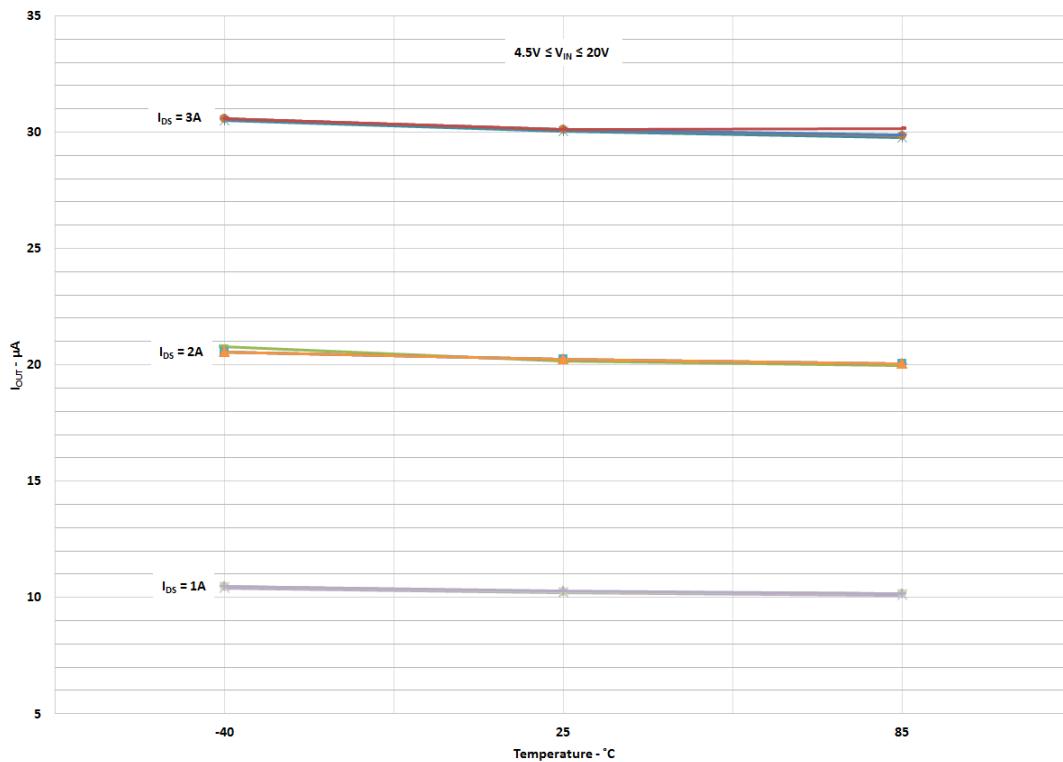
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I_{ACL} vs. Temperature and R_{SET}I_{ACL} vs. R_{SET} and V_{IN}

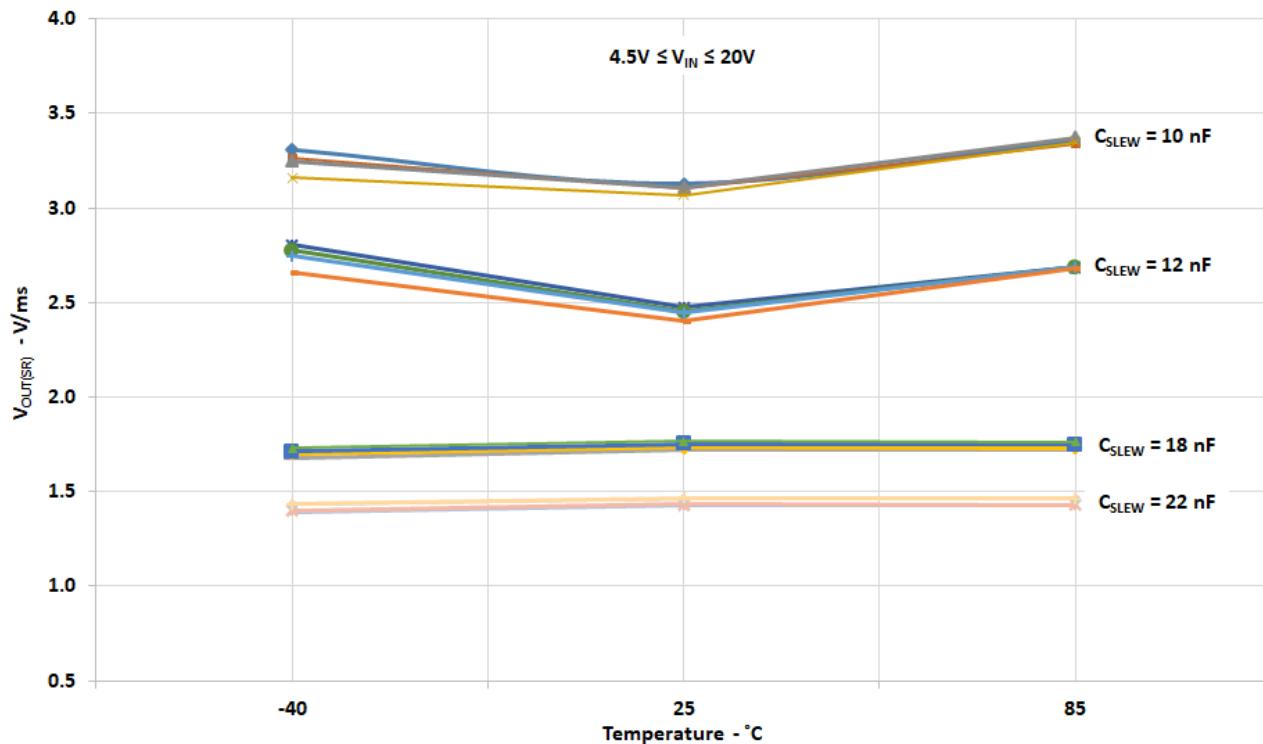
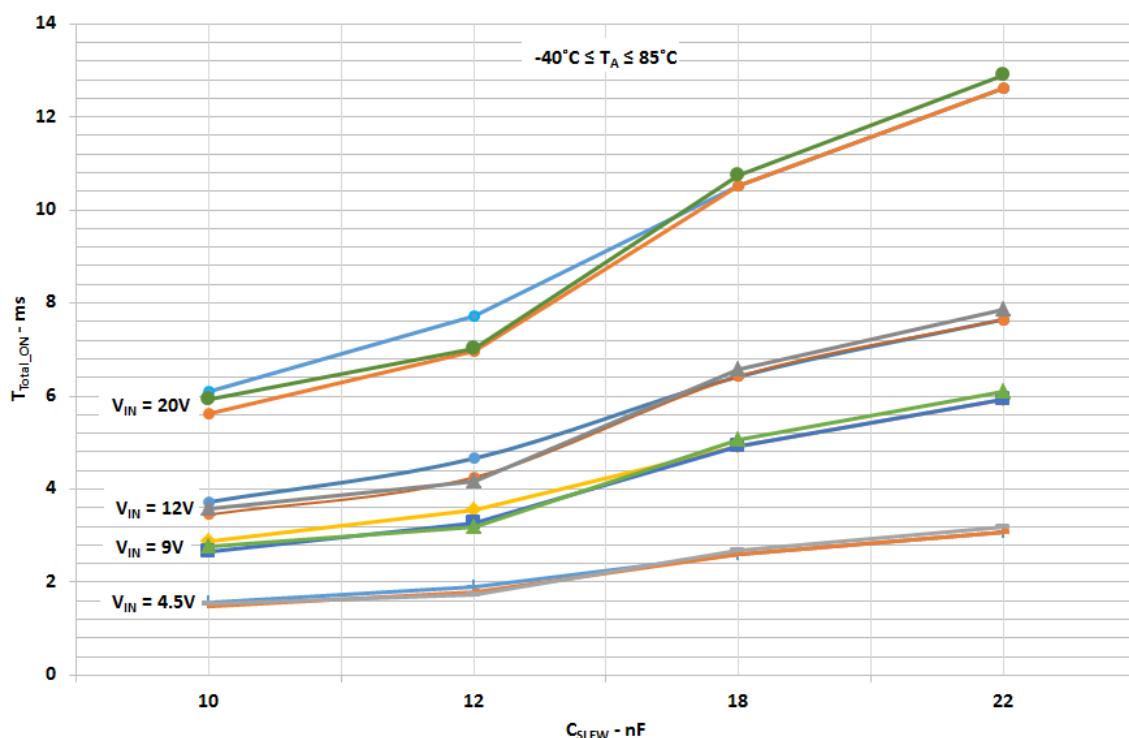
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 I_{OUT} vs. MOSFET IDS and V_{IN}  I_{OUT} vs. Temperature and MOSFET IDS

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V_{OUT} Slew Rate vs. Temperature, V_{IN}, and C_{SLEW}T_{Total_ON} vs. C_{SLEW}, V_{IN}, and Temperature

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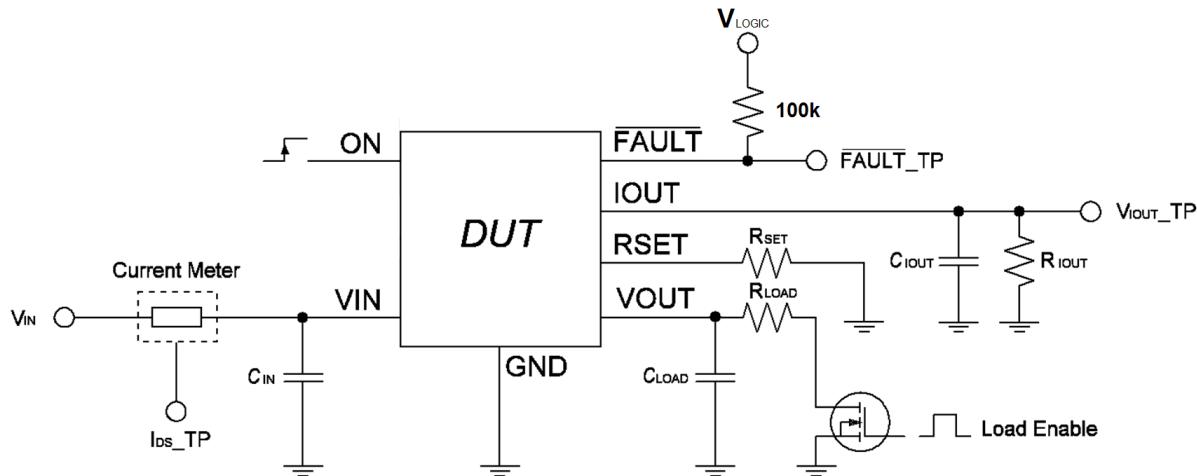
SLG59H1020V Application Diagram

Figure 1. Test setup Application Diagram

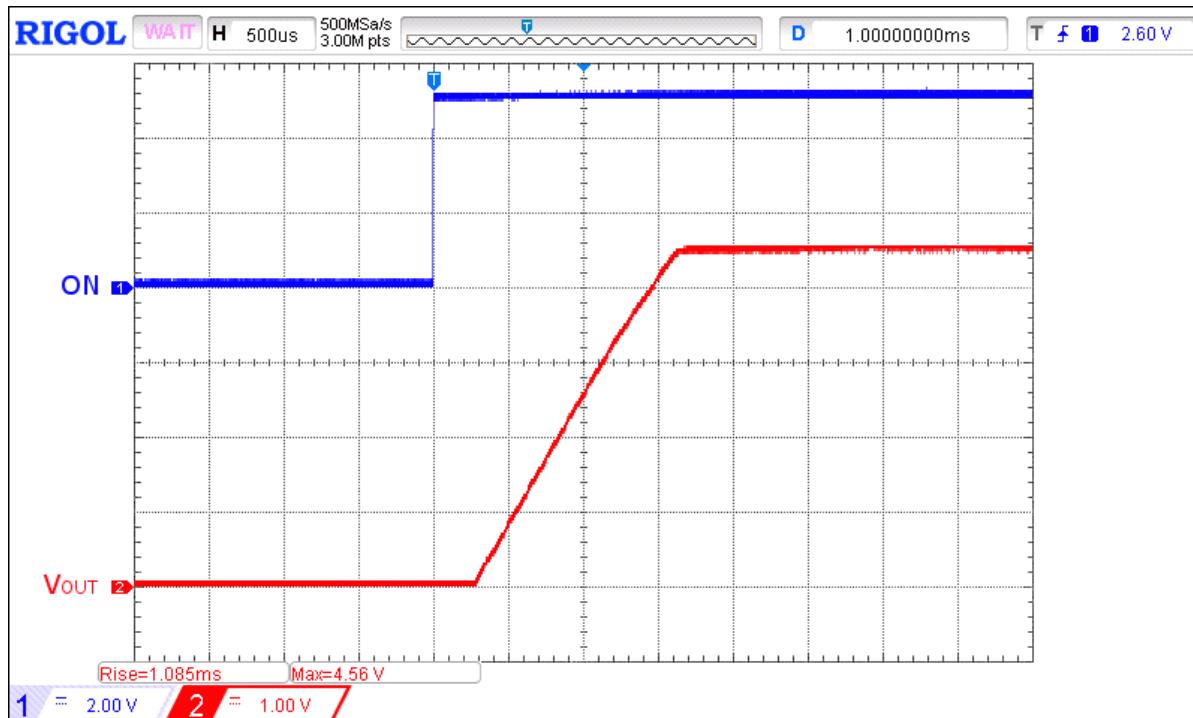
Typical Turn-on Waveforms

Figure 2. Typical Turn ON operation waveform for V_{IN} = 4.5 V, C_{SLEW} = 10 nF, C_{LOAD} = 10 μ F, R_{LOAD} = 100 Ω

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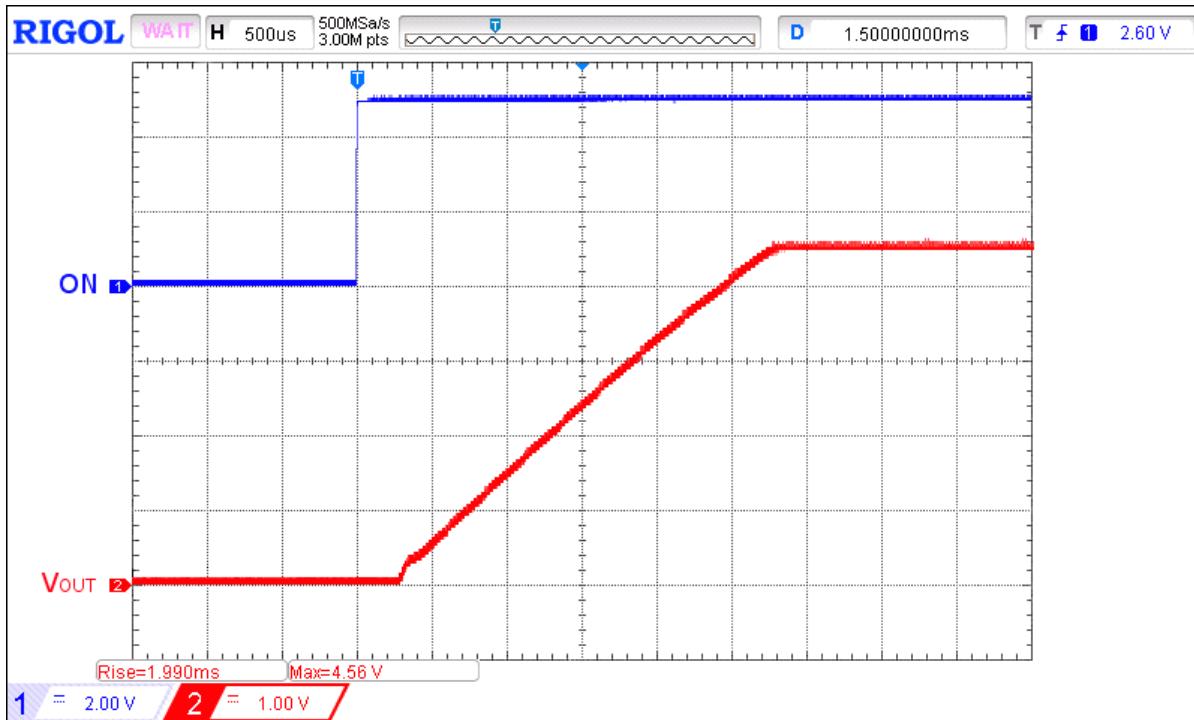


Figure 3. Typical Turn ON operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 18$ nF, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 100$ Ω

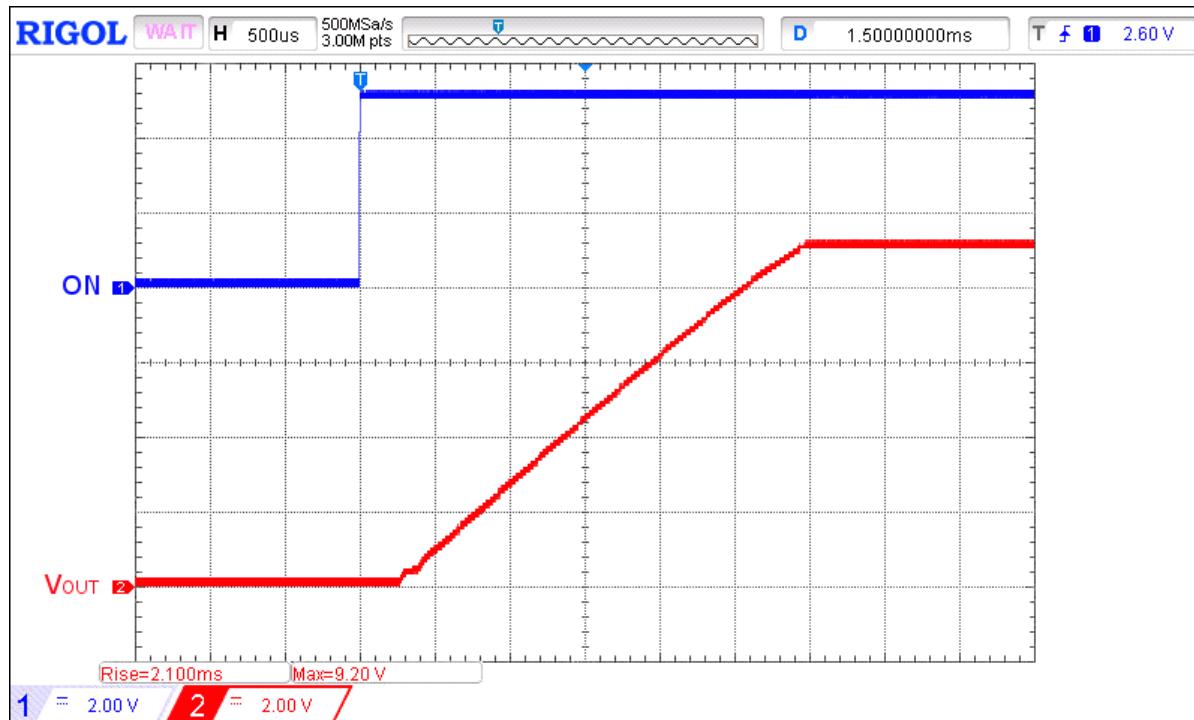


Figure 4. Typical Turn ON operation waveform for $V_{IN} = 9$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 100$ Ω

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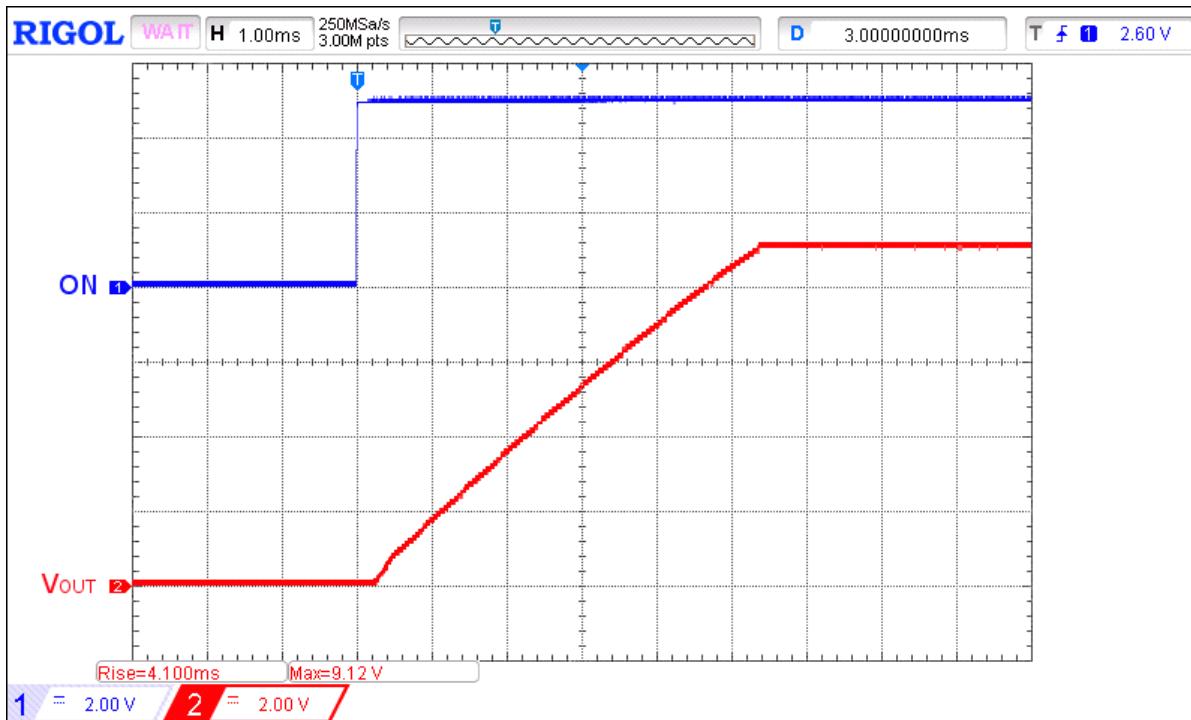


Figure 5. Typical Turn ON operation waveform for $V_{IN} = 9\text{ V}$, $C_{SLEW} = 18\text{ nF}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $R_{LOAD} = 100\text{ }\Omega$

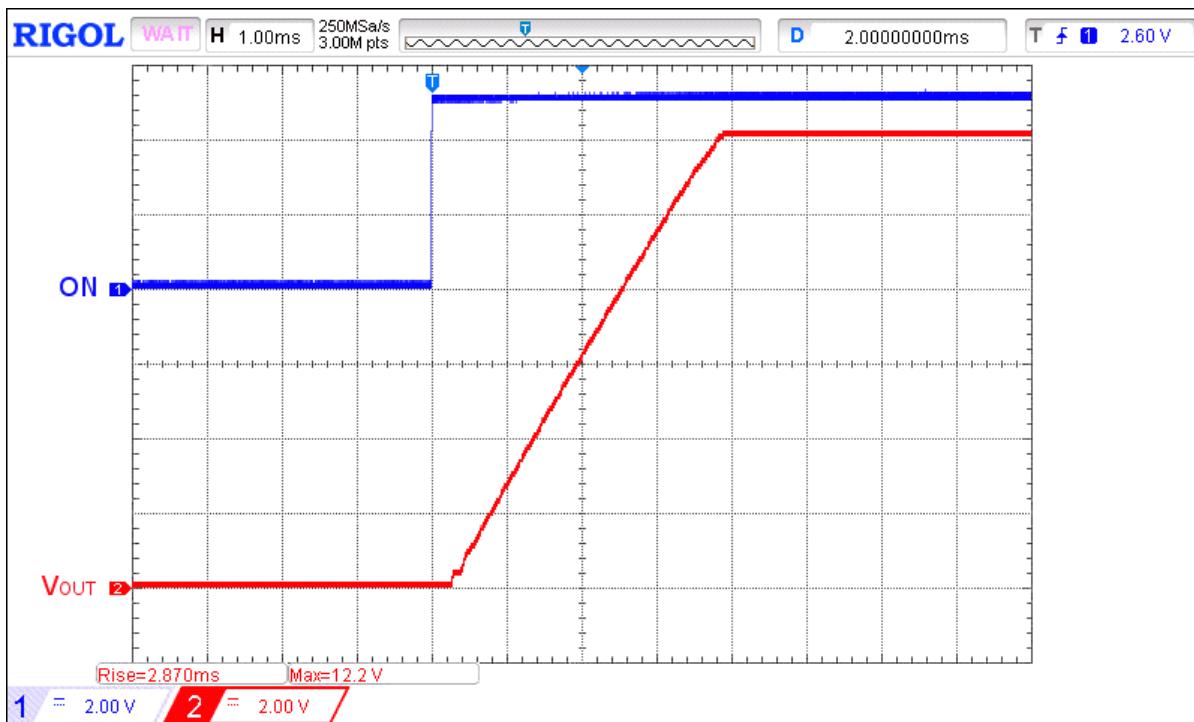


Figure 6. Typical Turn ON operation waveform for $V_{IN} = 12\text{ V}$, $C_{SLEW} = 10\text{ nF}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $R_{LOAD} = 100\text{ }\Omega$

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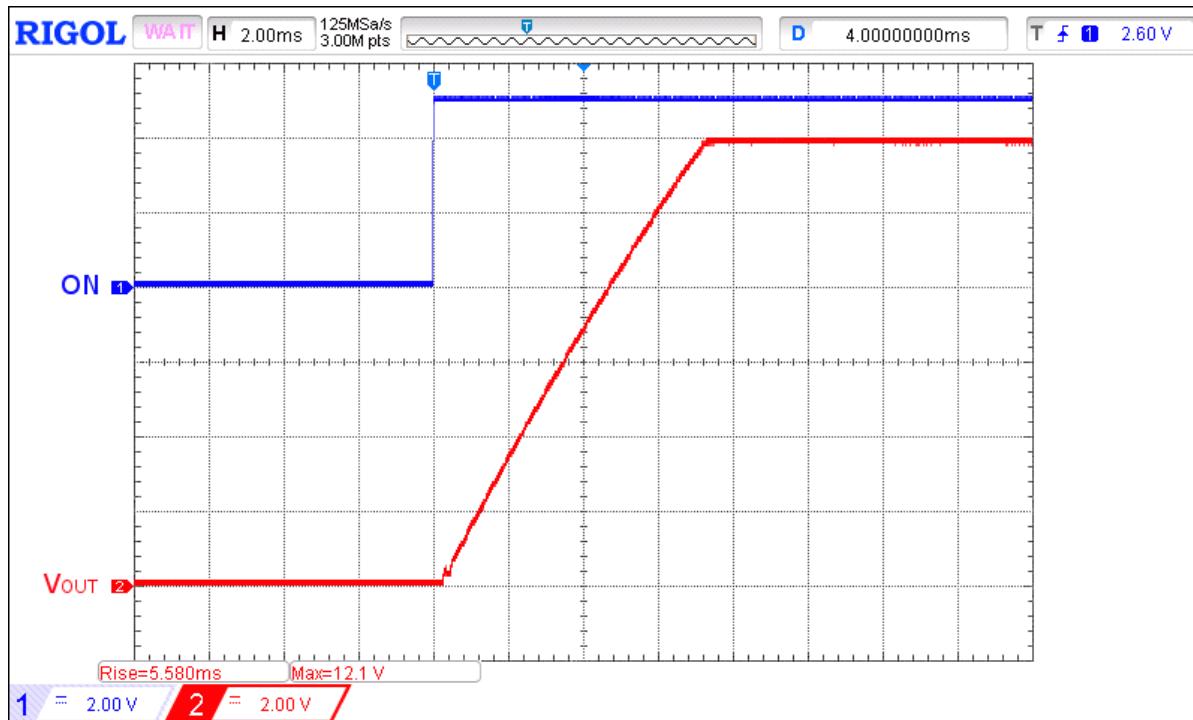


Figure 7. Typical Turn ON operation waveform for $V_{IN} = 12\text{ V}$, $C_{SLEW} = 18\text{ nF}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $R_{LOAD} = 100\text{ }\Omega$

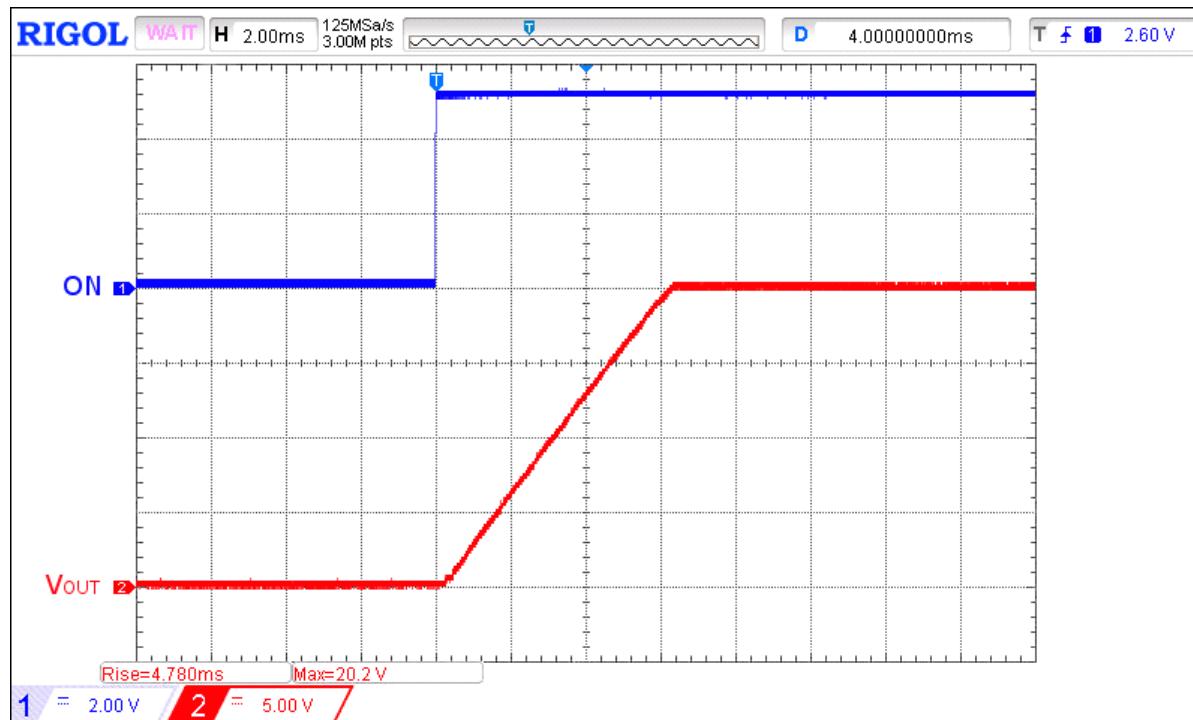


Figure 8. Typical Turn ON operation waveform for $V_{IN} = 20\text{ V}$, $C_{SLEW} = 10\text{ nF}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $R_{LOAD} = 100\text{ }\Omega$

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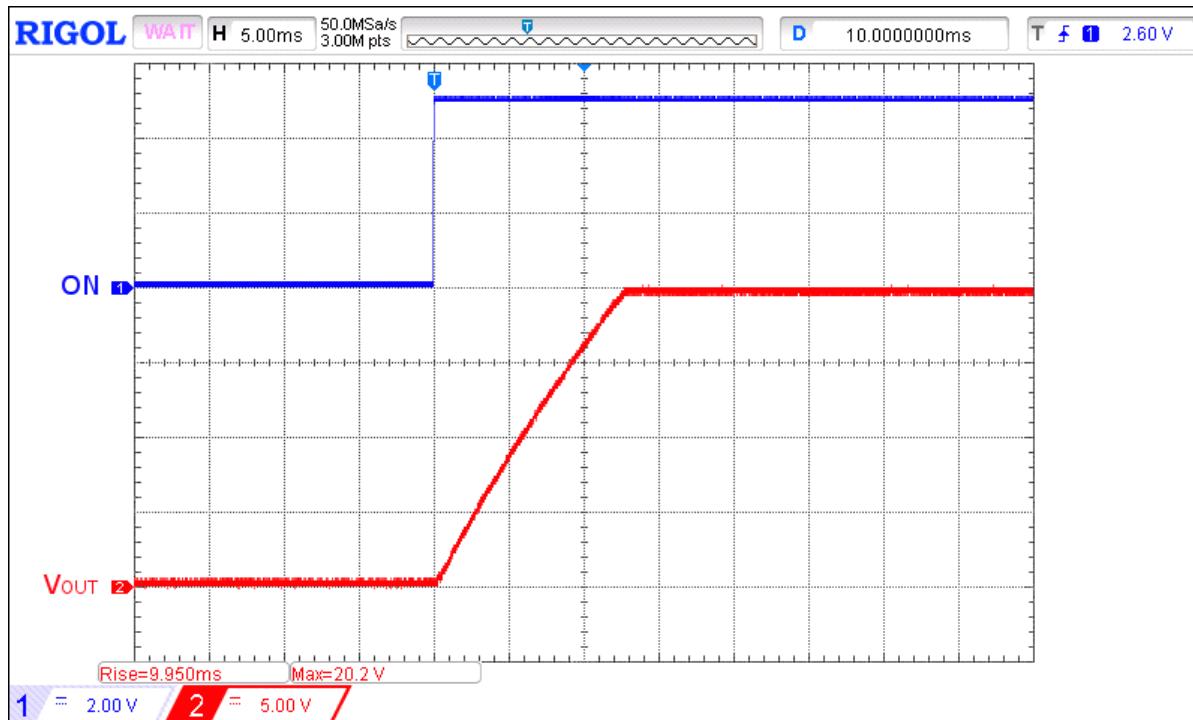


Figure 9. Typical Turn ON operation waveform for $V_{IN} = 20$ V, $C_{SLEW} = 18$ nF, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 100$ Ω

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Typical Turn-off Waveforms

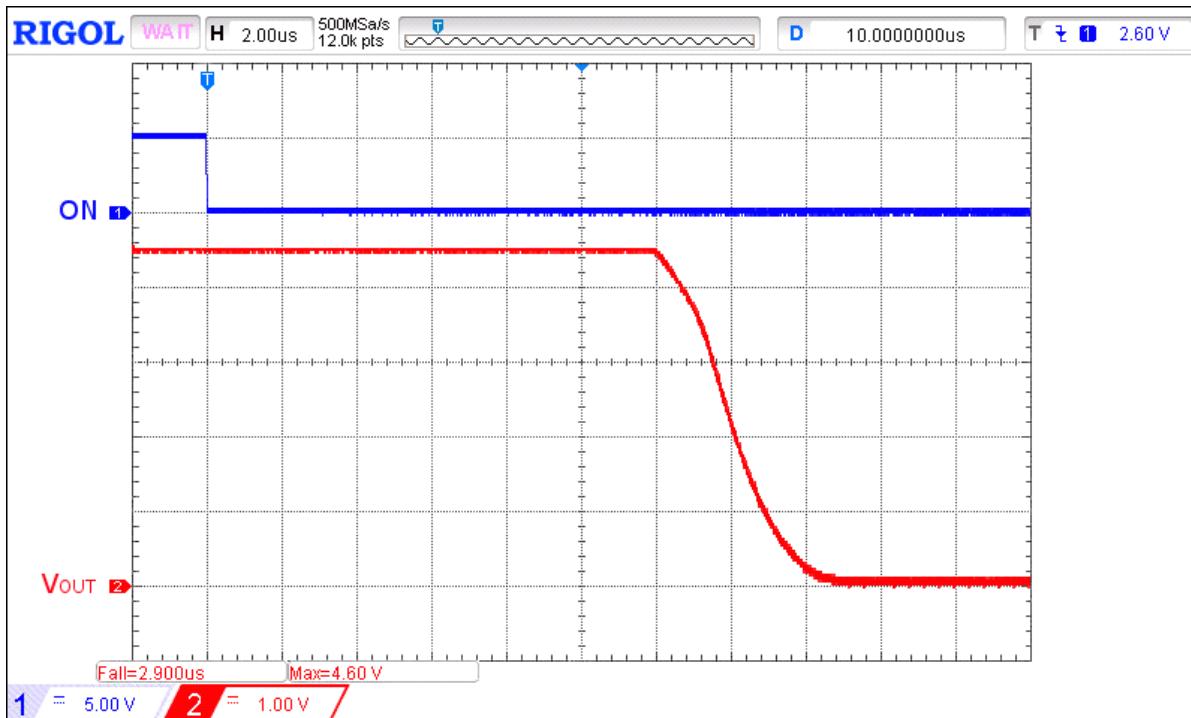


Figure 10. Typical Turn OFF operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 10$ nF, no C_{LOAD} , $R_{LOAD} = 100$ Ω

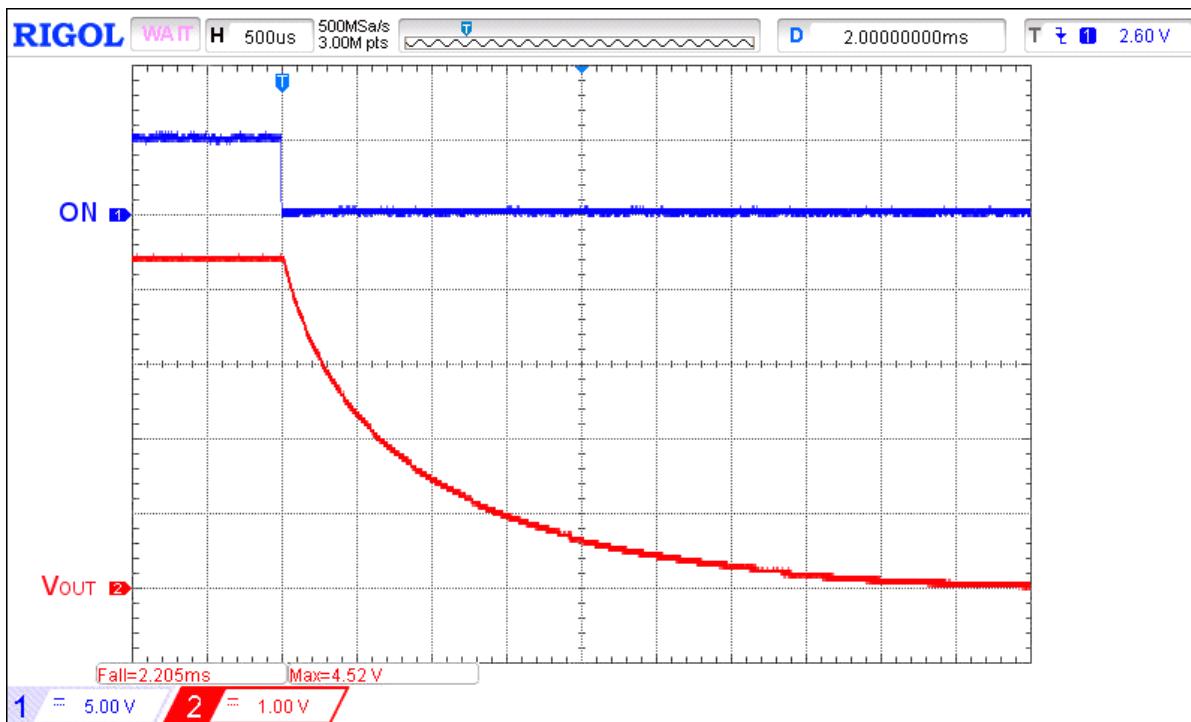


Figure 11. Typical Turn OFF operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μF, $R_{LOAD} = 100$ Ω

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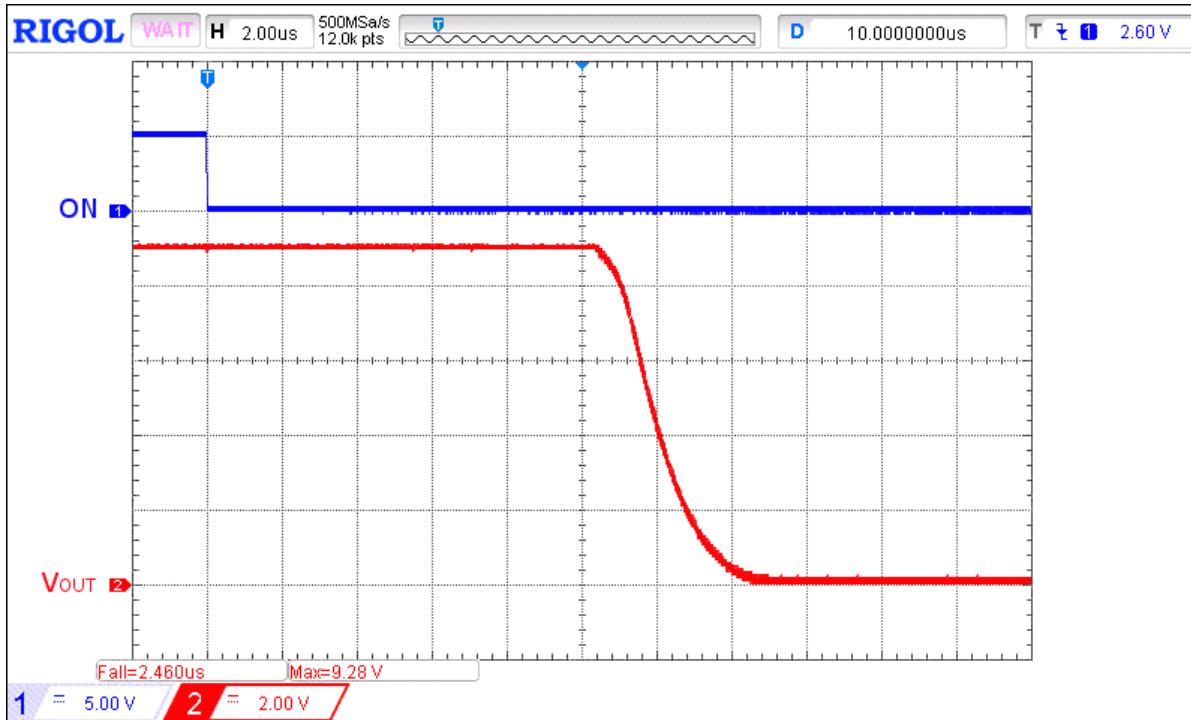


Figure 12. Typical Turn OFF operation waveform for $V_{IN} = 9$ V, $C_{SLEW} = 10$ nF, no C_{LOAD} , $R_{LOAD} = 100$ Ω

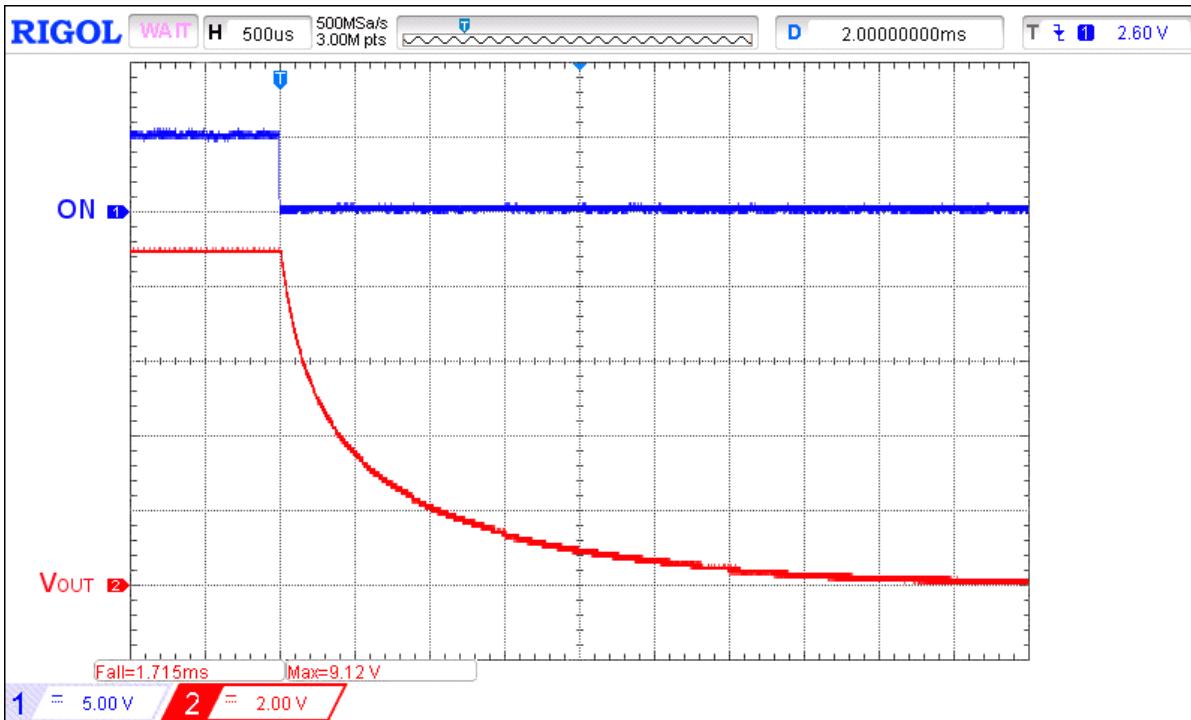


Figure 13. Typical Turn OFF operation waveform for $V_{IN} = 9$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μF, $R_{LOAD} = 100$ Ω

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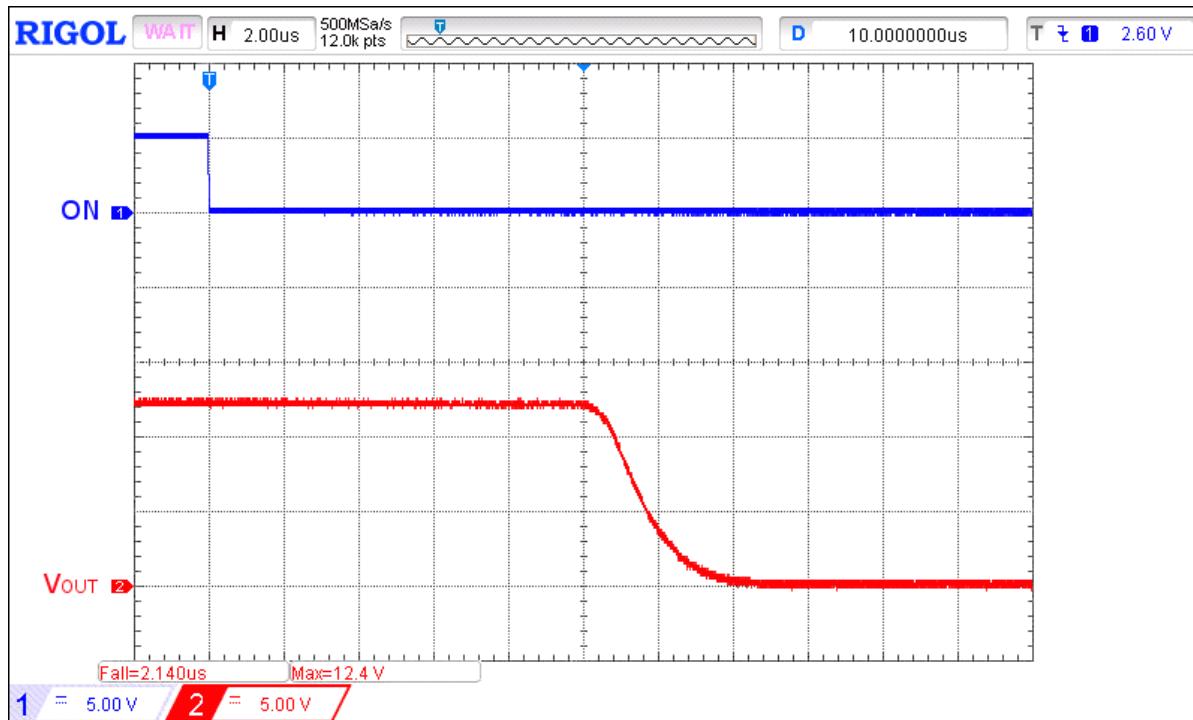


Figure 14. Typical Turn OFF operation waveform for $V_{IN} = 12$ V, $C_{SLEW} = 10$ nF, no C_{LOAD} , $R_{LOAD} = 100$ Ω

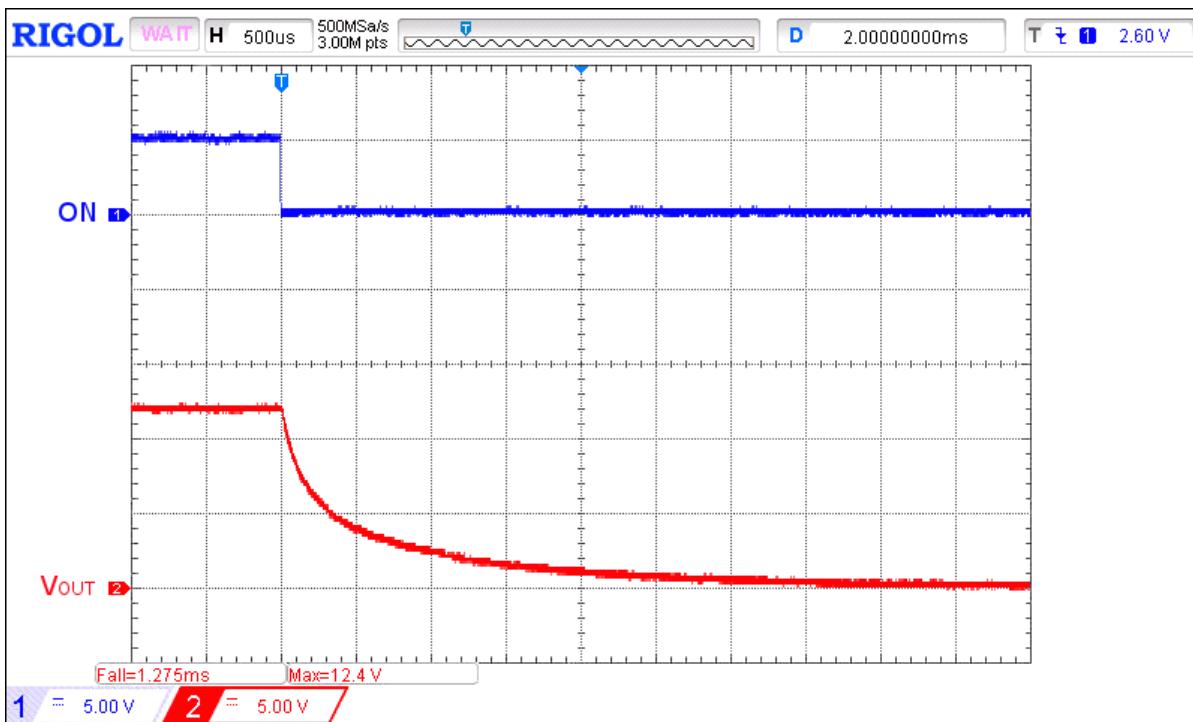


Figure 15. Typical Turn OFF operation waveform for $V_{IN} = 12$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μF, $R_{LOAD} = 100$ Ω

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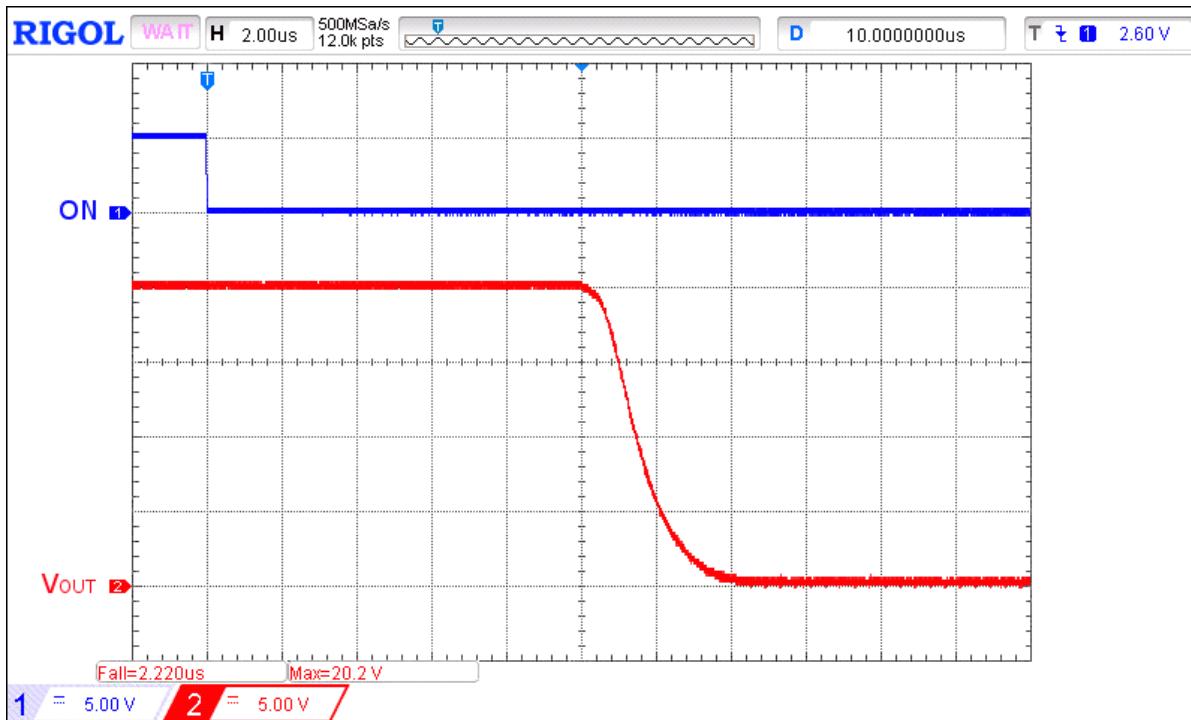


Figure 16. Typical Turn OFF operation waveform for $V_{IN} = 20\text{ V}$, $C_{SLEW} = 10\text{ nF}$, no C_{LOAD} , $R_{LOAD} = 100\text{ }\Omega$

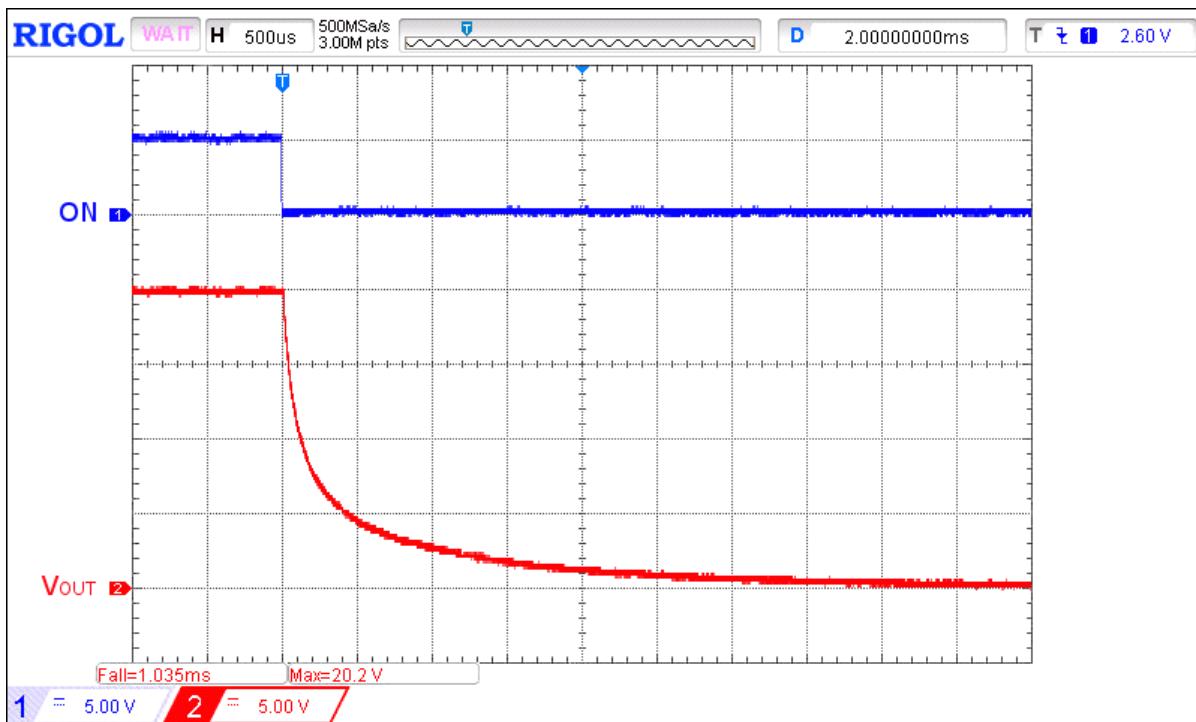


Figure 17. Typical Turn OFF operation waveform for $V_{IN} = 20\text{ V}$, $C_{SLEW} = 10\text{ nF}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $R_{LOAD} = 100\text{ }\Omega$

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Typical ACL Operation Waveforms

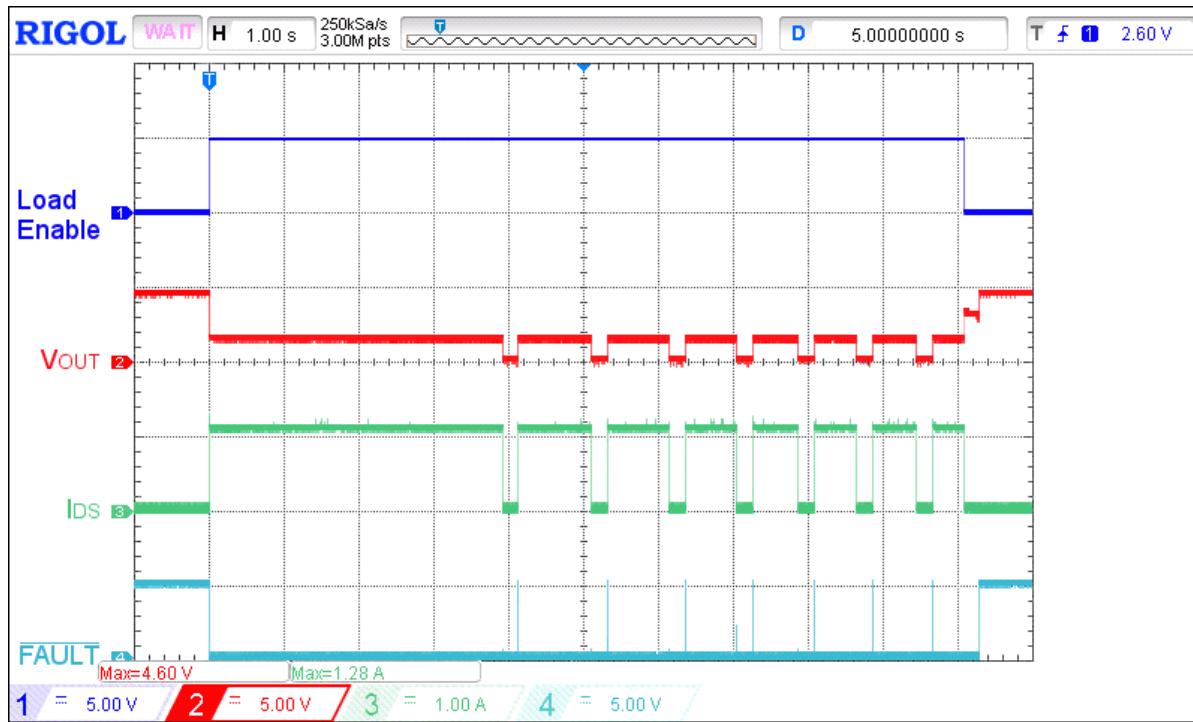


Figure 18. Typical ACL operation waveform for $V_{IN} = 4.5\text{ V}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $I_{ACL} = 1\text{ A}$, $R_{SET} = 91\text{ k}\Omega$

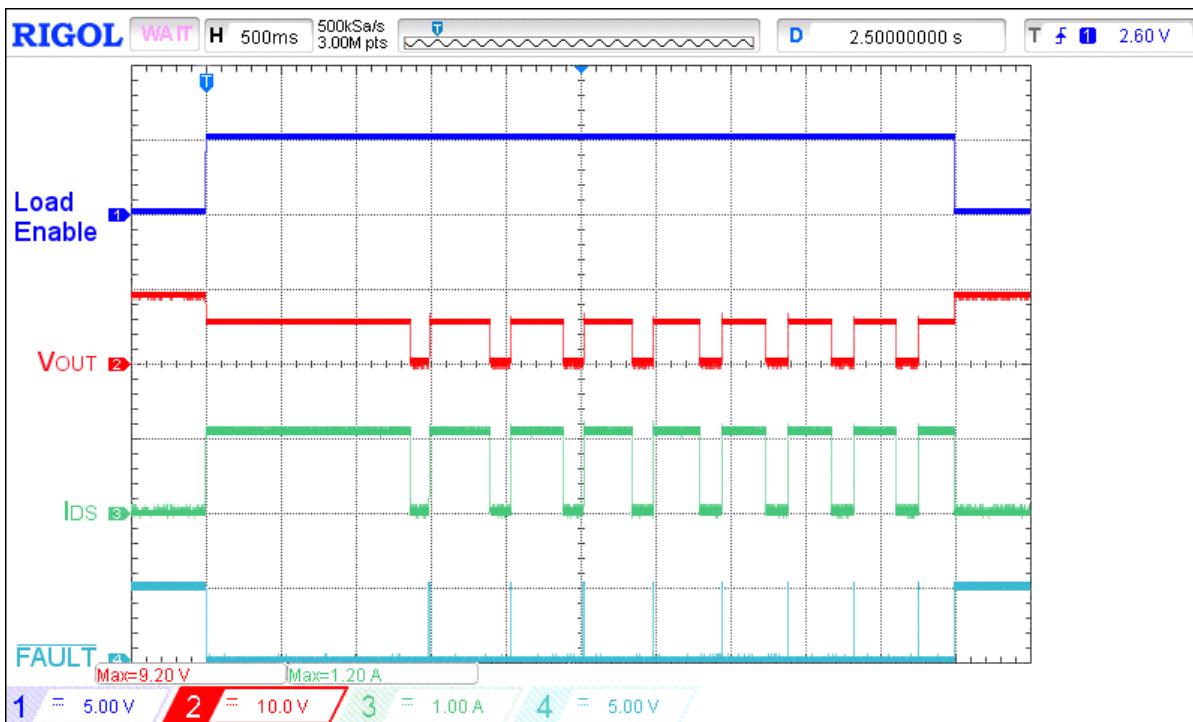


Figure 19. Typical ACL operation waveform for $V_{IN} = 9\text{ V}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $I_{ACL} = 1\text{ A}$, $R_{SET} = 91\text{ k}\Omega$

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

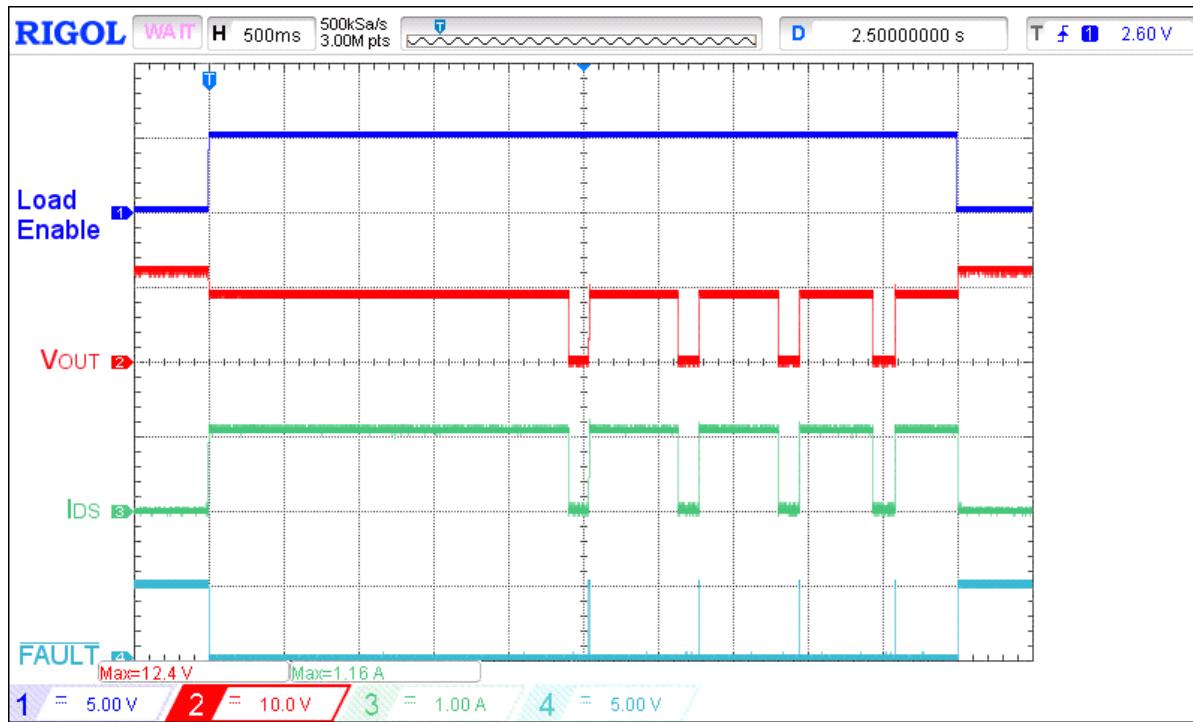


Figure 20. Typical ACL operation waveform for $V_{IN} = 12$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91$ kΩ

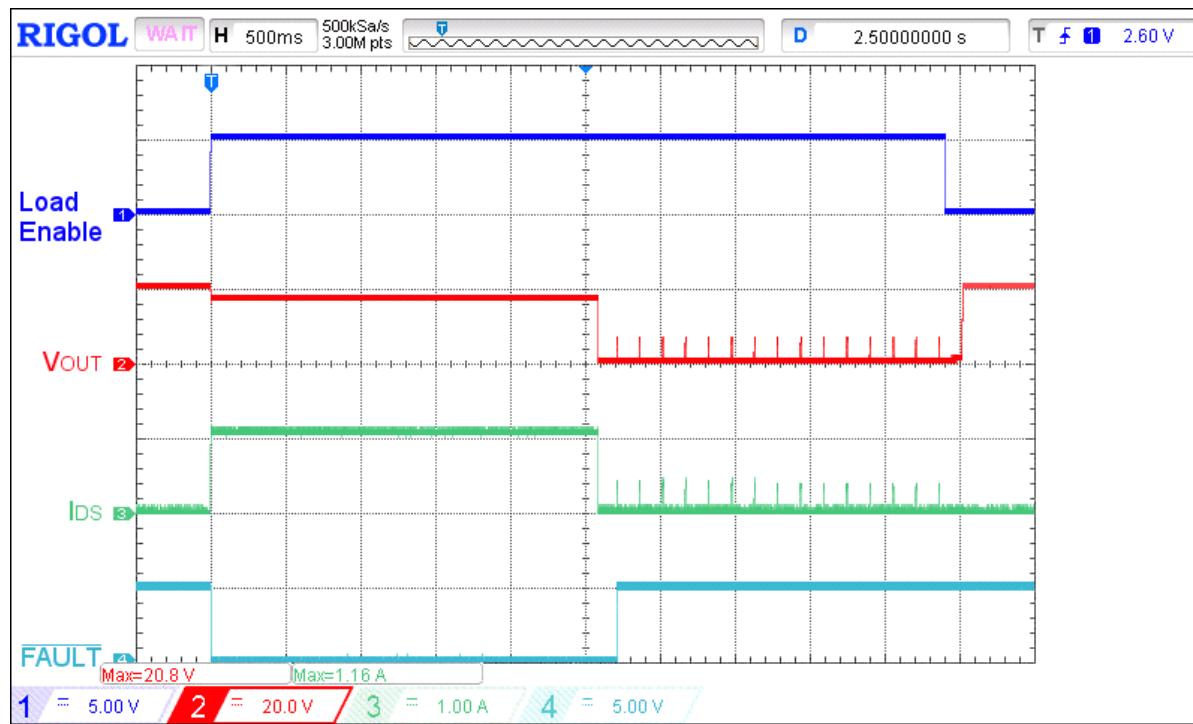


Figure 21. Typical ACL operation waveform for $V_{IN} = 20$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91$ kΩ

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

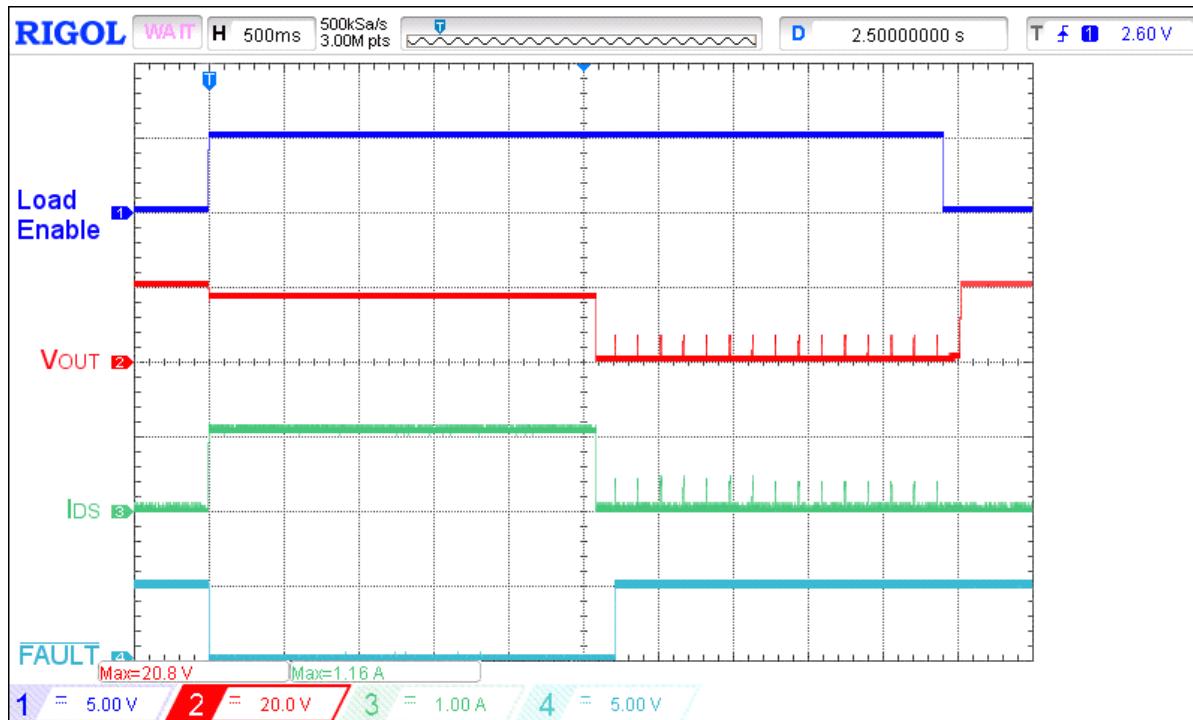


Figure 22. Thermally induced SOA shutdown for V_{IN} = 20 V, C_{LOAD} = 10 µF, I_{ACL} = 1 A, R_{SET} = 91 kΩ

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Typical FAULT Operation Waveforms

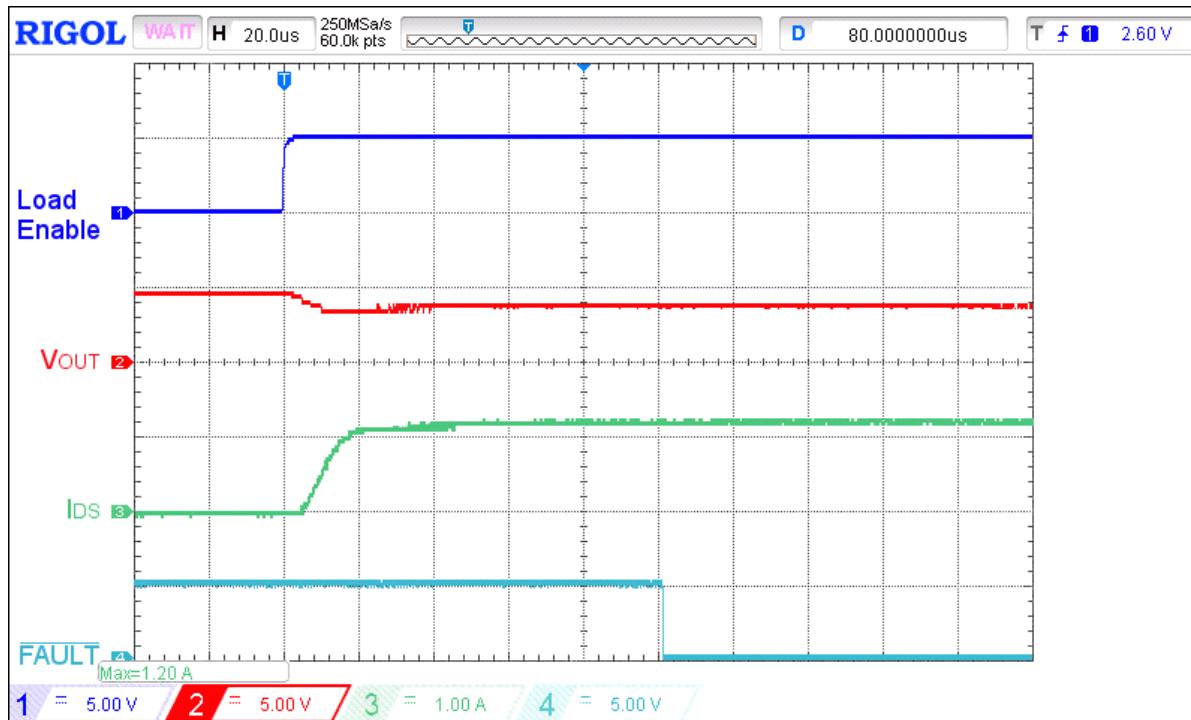


Figure 23. Typical FAULT assertion waveform for $V_{IN} = 4.5\text{ V}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $I_{ACL} = 1\text{ A}$, $R_{SET} = 91\text{ k}\Omega$, switch on $3.8\text{ }\Omega$ load

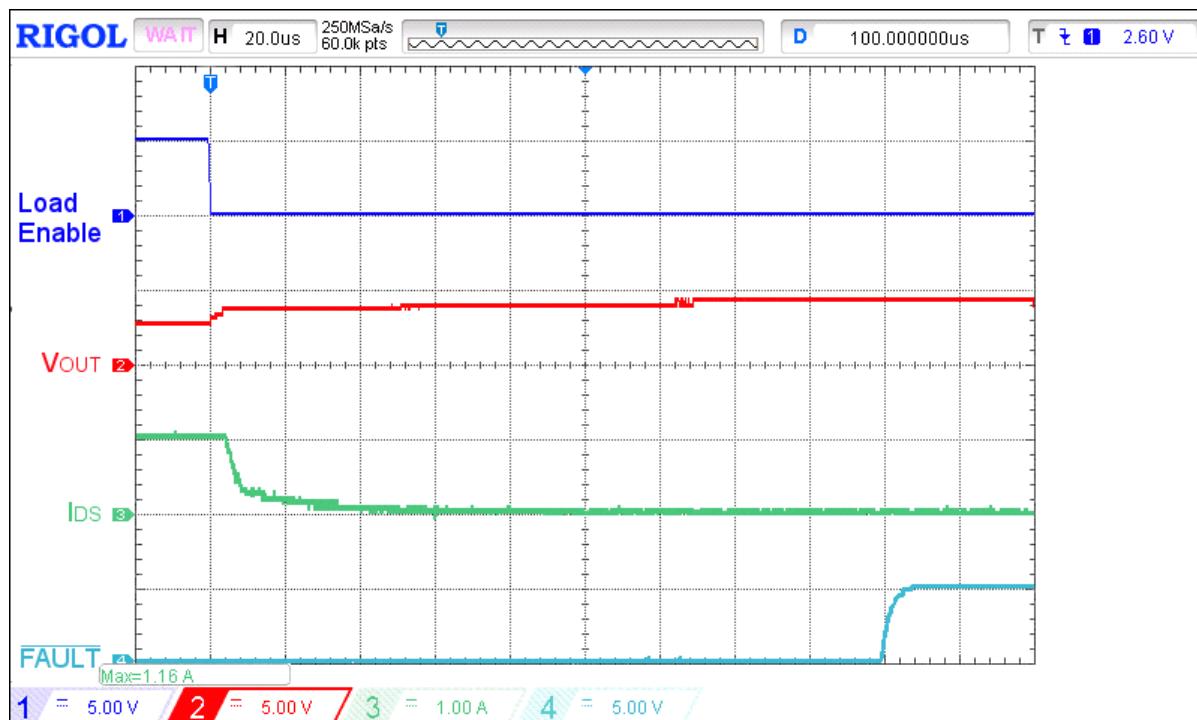


Figure 24. Typical FAULT de-assertion waveform for $V_{IN} = 4.5\text{ V}$, $C_{LOAD} = 10\text{ }\mu\text{F}$, $I_{ACL} = 1\text{ A}$, $R_{SET} = 91\text{ k}\Omega$, switch out $3.8\text{ }\Omega$ load

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

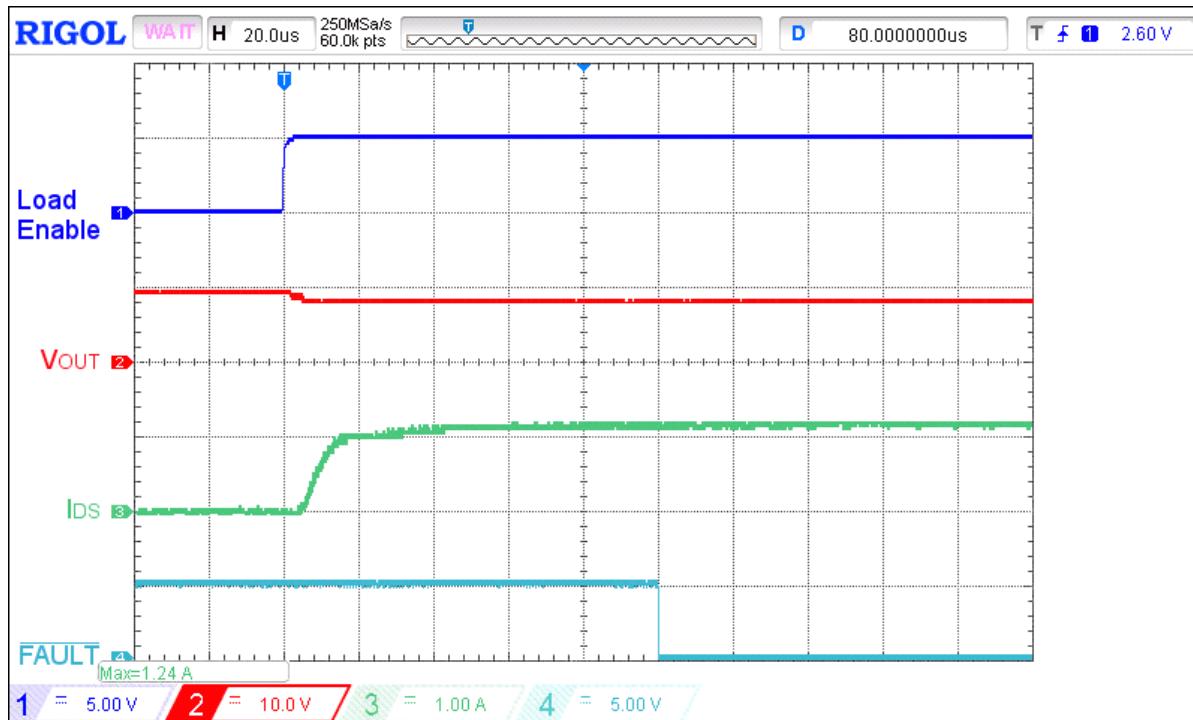


Figure 25. Typical FAULT assertion waveform for $V_{IN} = 9$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91 \text{ k}\Omega$, switch on 6.7Ω load

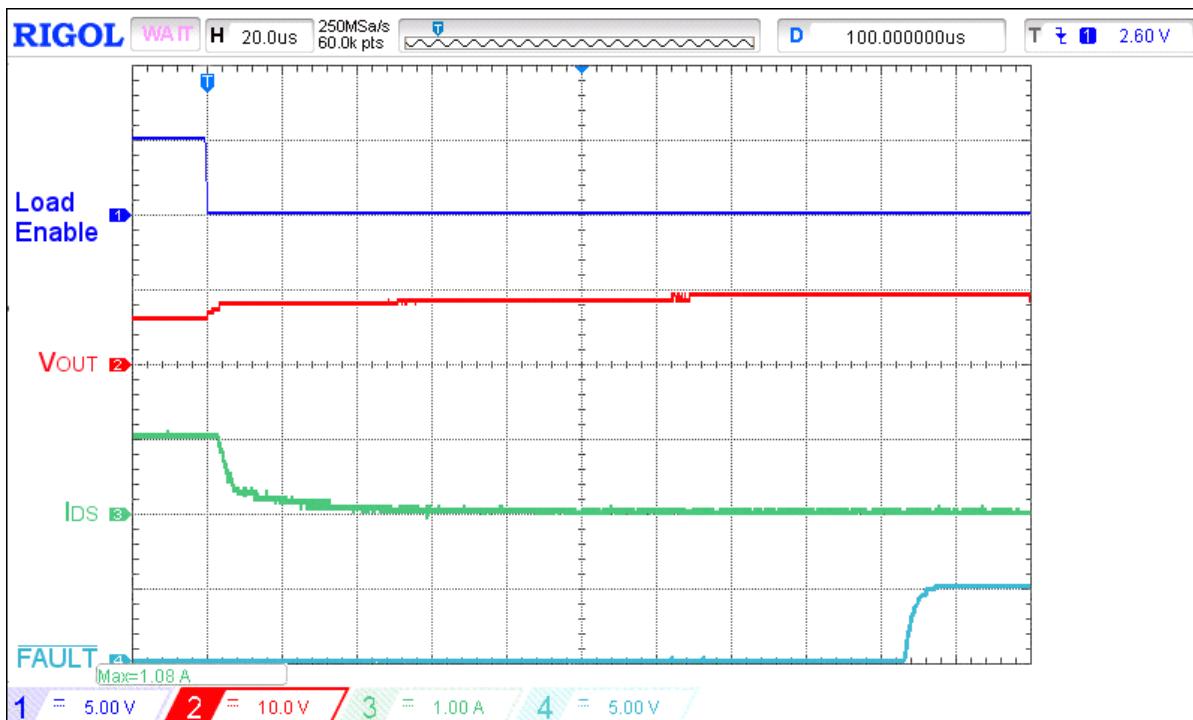


Figure 26. Typical FAULT de-assertion waveform for $V_{IN} = 9$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91 \text{ k}\Omega$, switch out 6.7Ω load

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

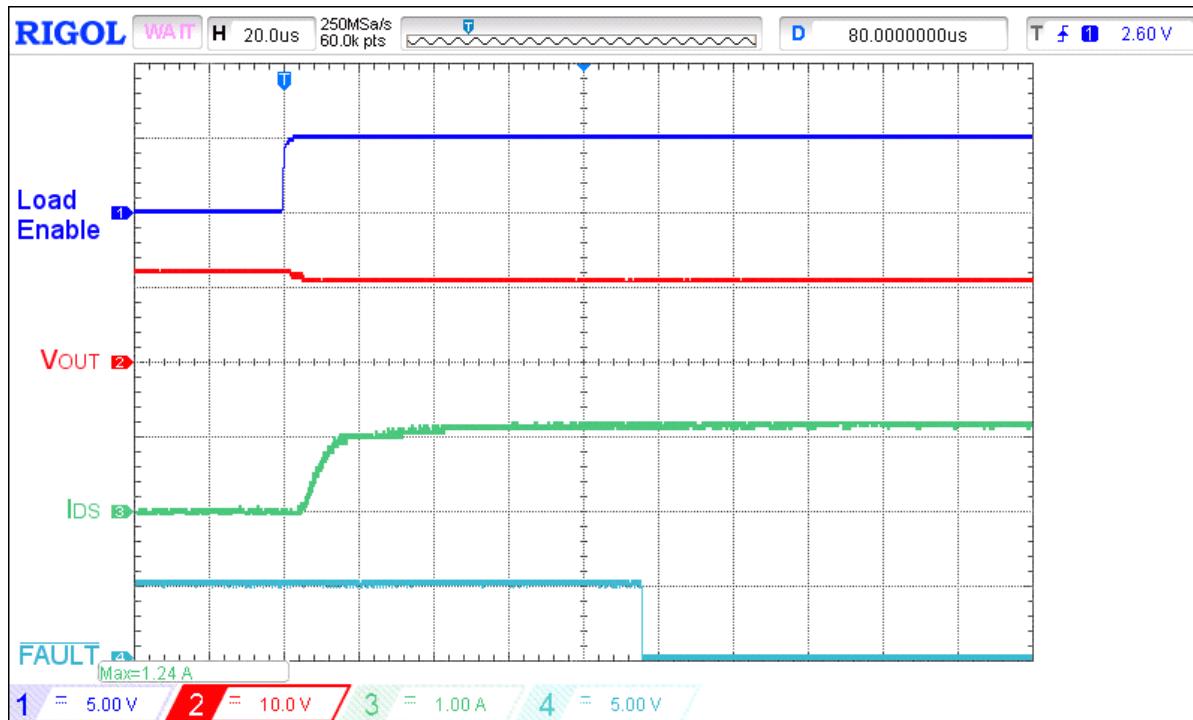


Figure 27. Typical FAULT assertion waveform for $V_{IN} = 12$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91 \text{ k}\Omega$, switch on 9 Ω load

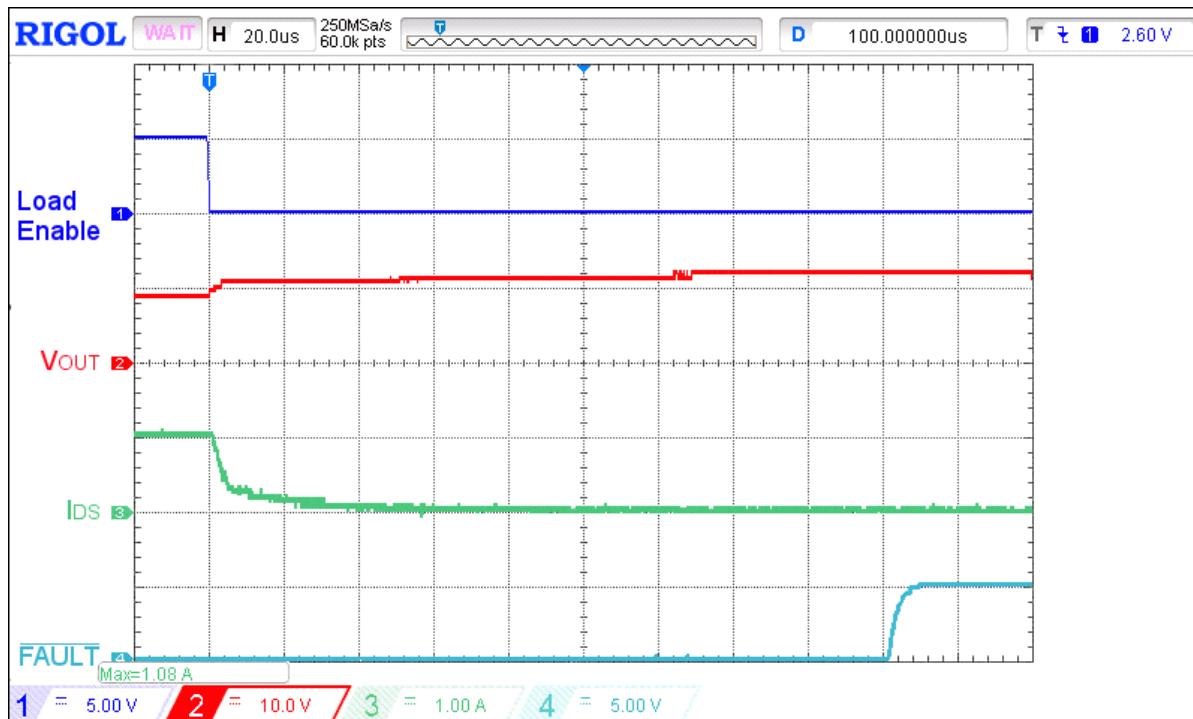


Figure 28. Typical FAULT de-assertion waveform for $V_{IN} = 12$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91 \text{ k}\Omega$, switch out 9 Ω load

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

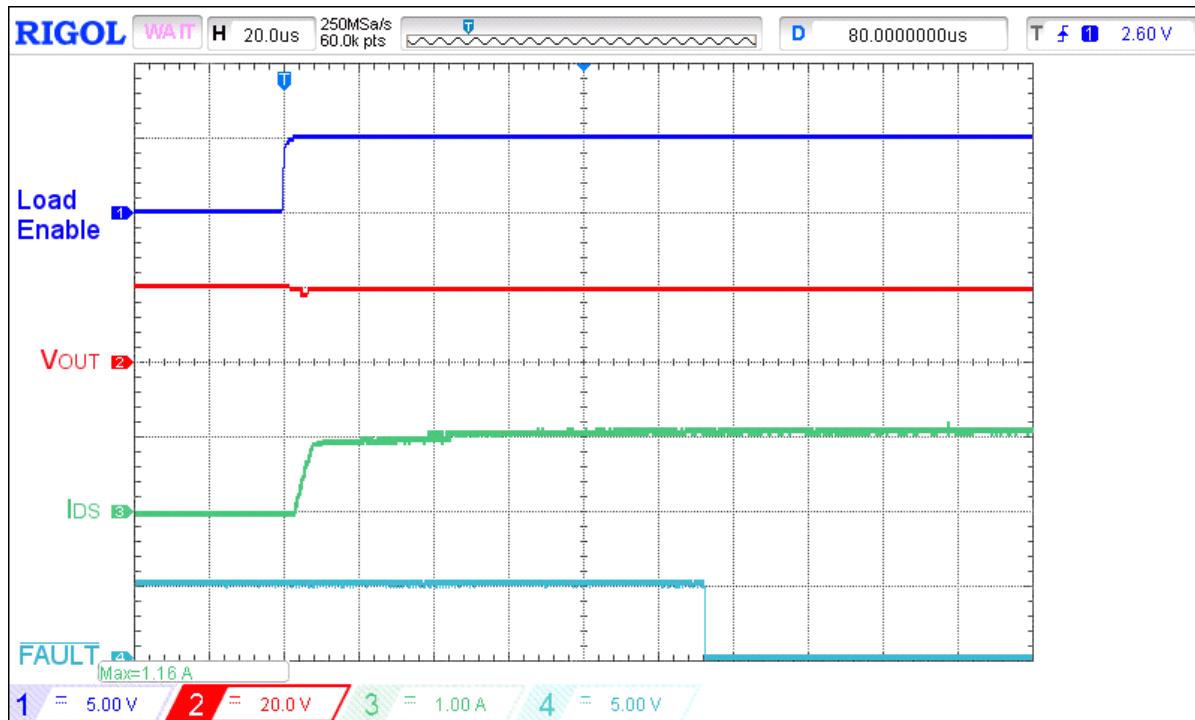


Figure 29. Typical FAULT assertion waveform for $V_{IN} = 20$ V, $C_{LOAD} = 10$ μ F, $I_{ACL} = 1$ A, $R_{SET} = 91$ k Ω , switch on 15 Ω load

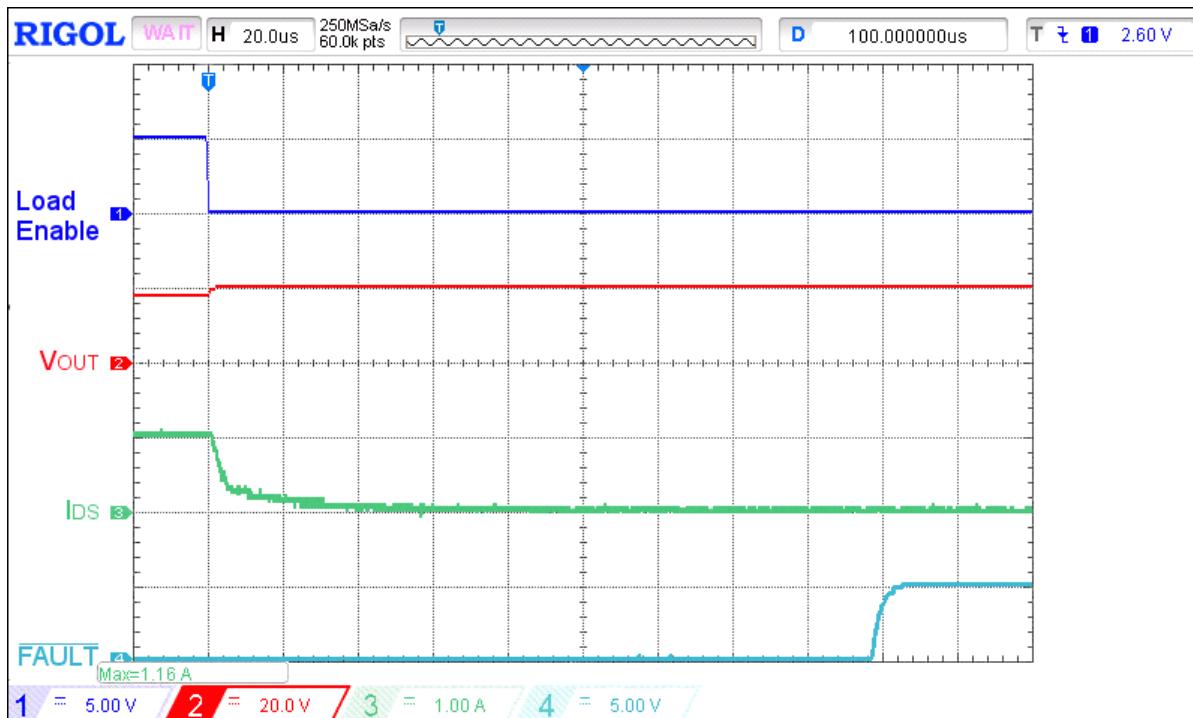


Figure 30. Typical FAULT de-assertion waveform for $V_{IN} = 20$ V, $C_{LOAD} = 10$ μ F, $I_{ACL} = 1$ A, $R_{SET} = 91$ k Ω , switch out 15 Ω load

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

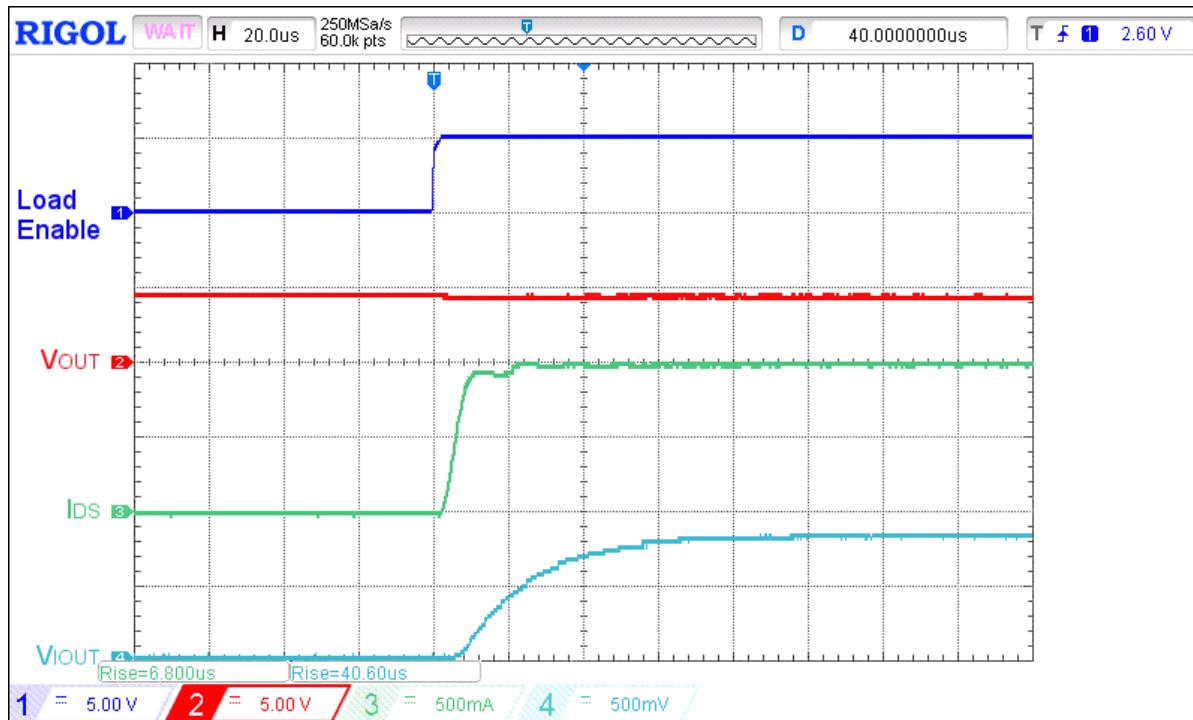
Typical I_{OUT} Response Time Waveforms

Figure 31. Typical I_{OUT} response time waveform for $V_{IN} = 4.5$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 4.5$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 0 A to 1 A

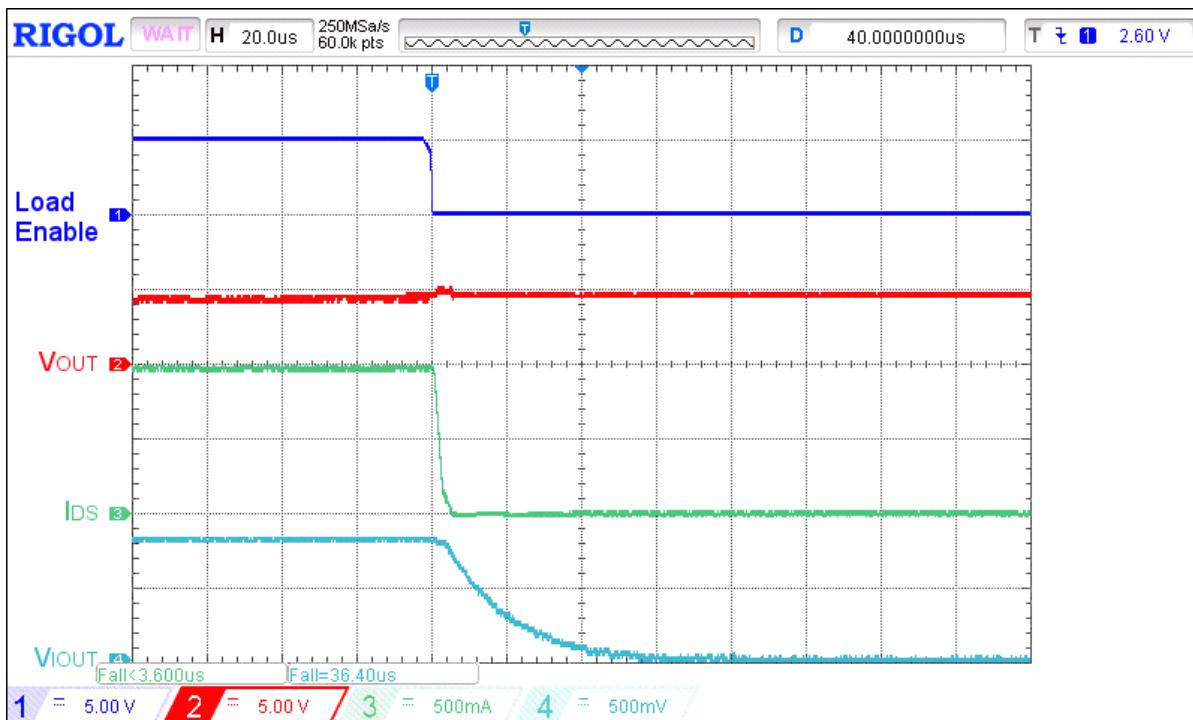


Figure 32. Typical I_{OUT} response time waveform for $V_{IN} = 4.5$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 4.5$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 1 A to 0 A

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

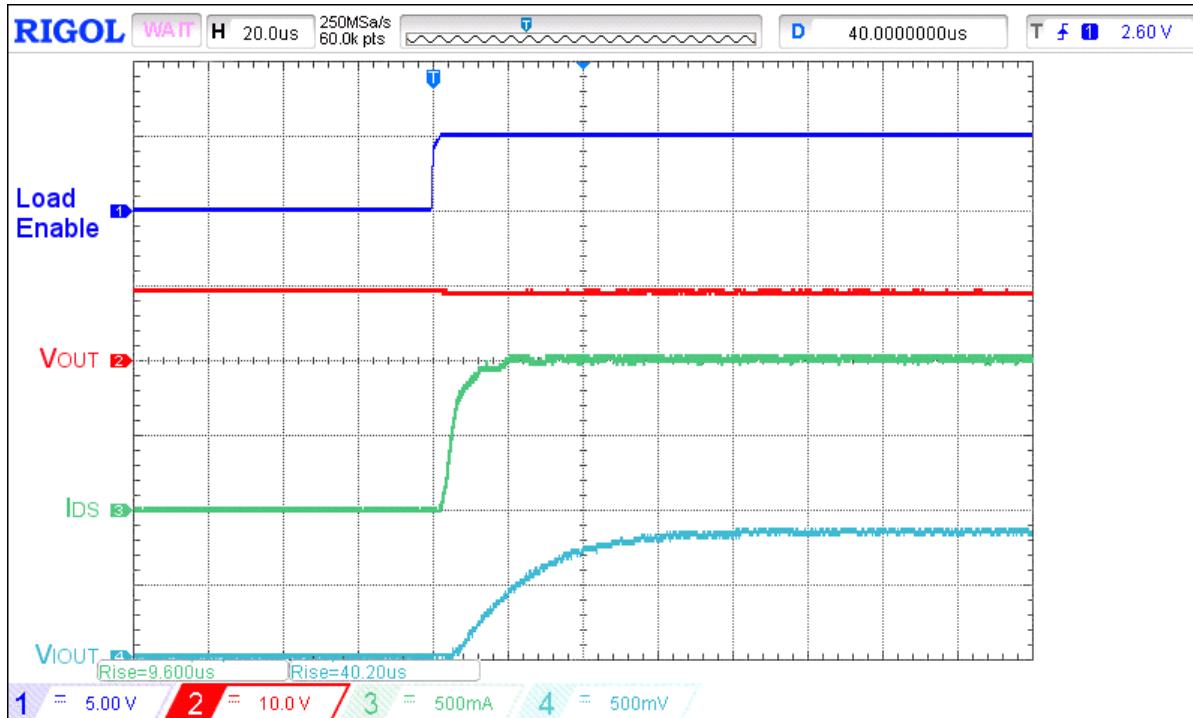


Figure 33. Typical I_{OUT} response time waveform for $V_{IN} = 9$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 9$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 0 A to 1 A

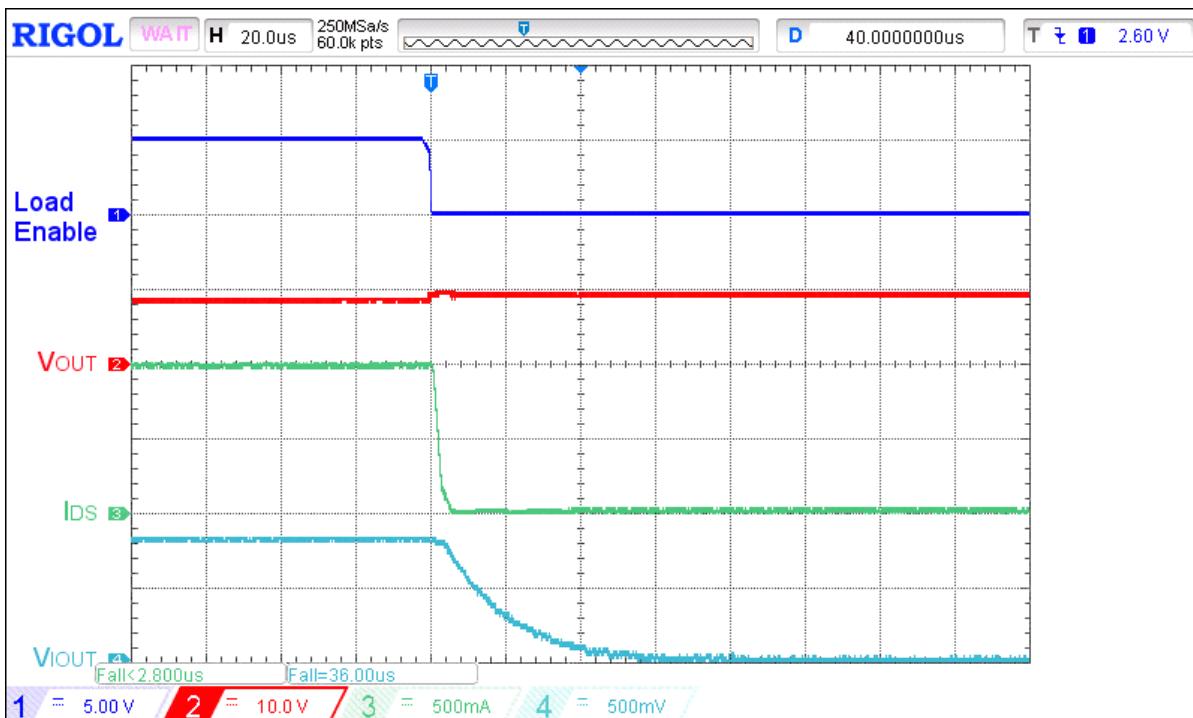


Figure 34. Typical I_{OUT} response time waveform for $V_{IN} = 9$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 9$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 1 A to 0 A

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

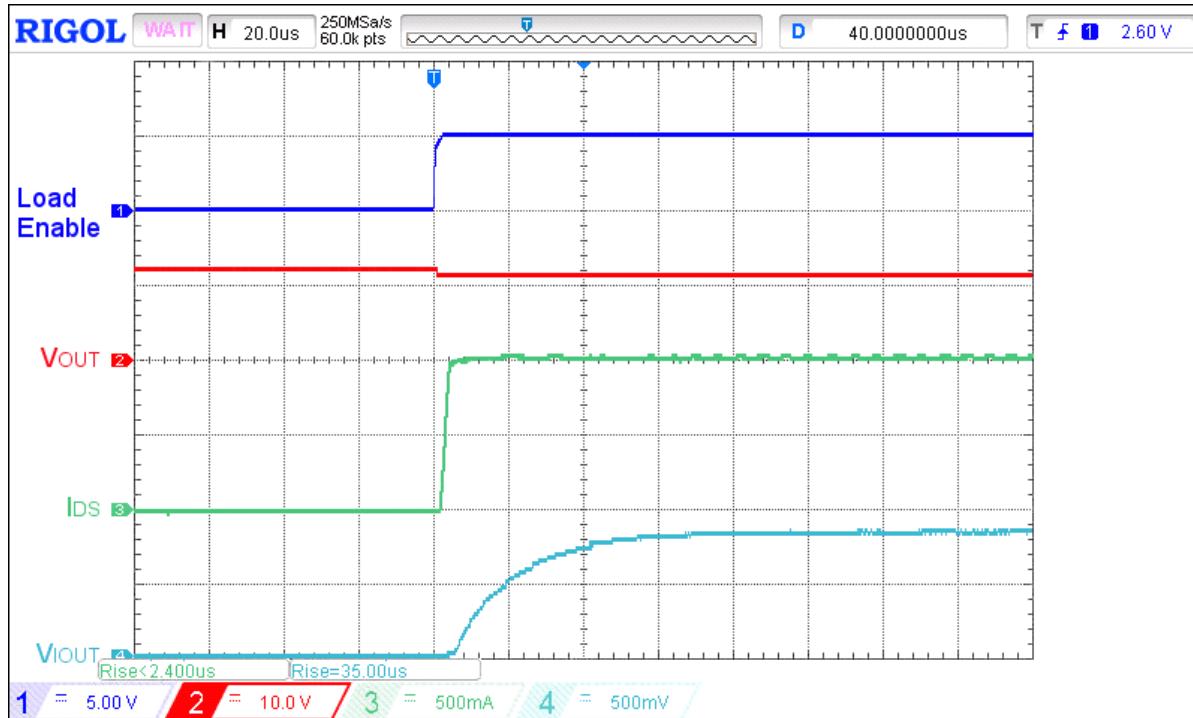


Figure 35. Typical I_{OUT} response time waveform for $V_{IN} = 12$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 12$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 0 A to 1 A

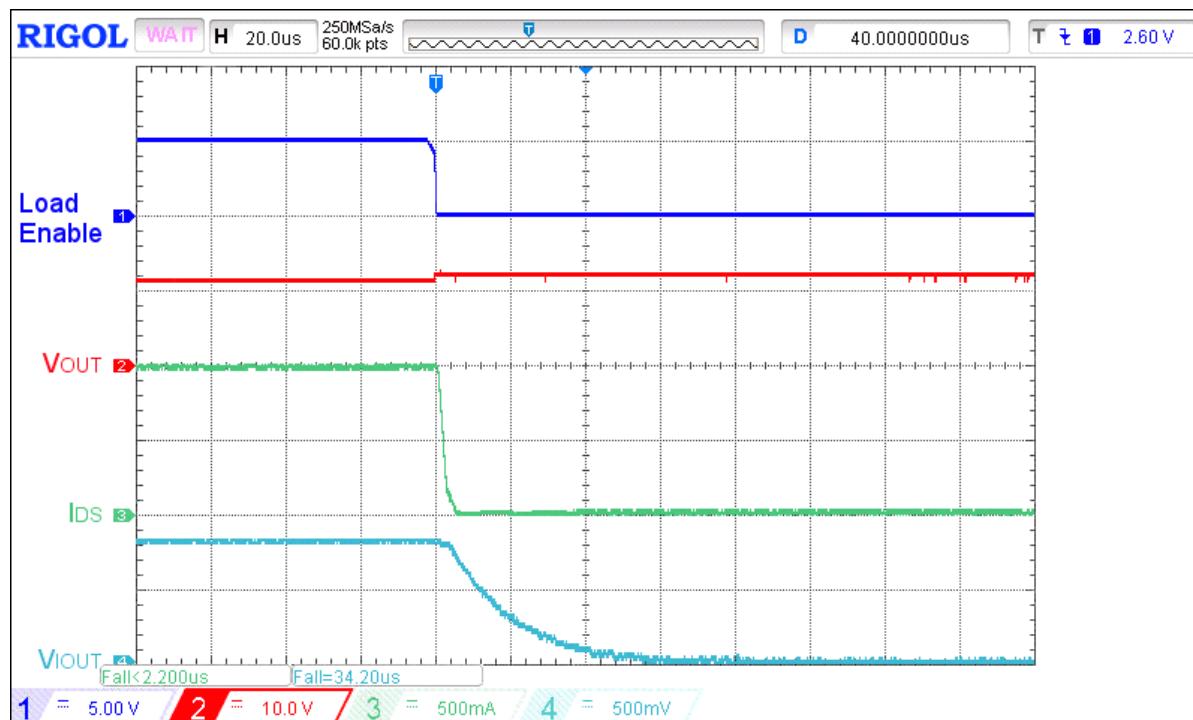


Figure 36. Typical I_{OUT} response time waveform for $V_{IN} = 12$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 12$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 1 A to 0 A

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

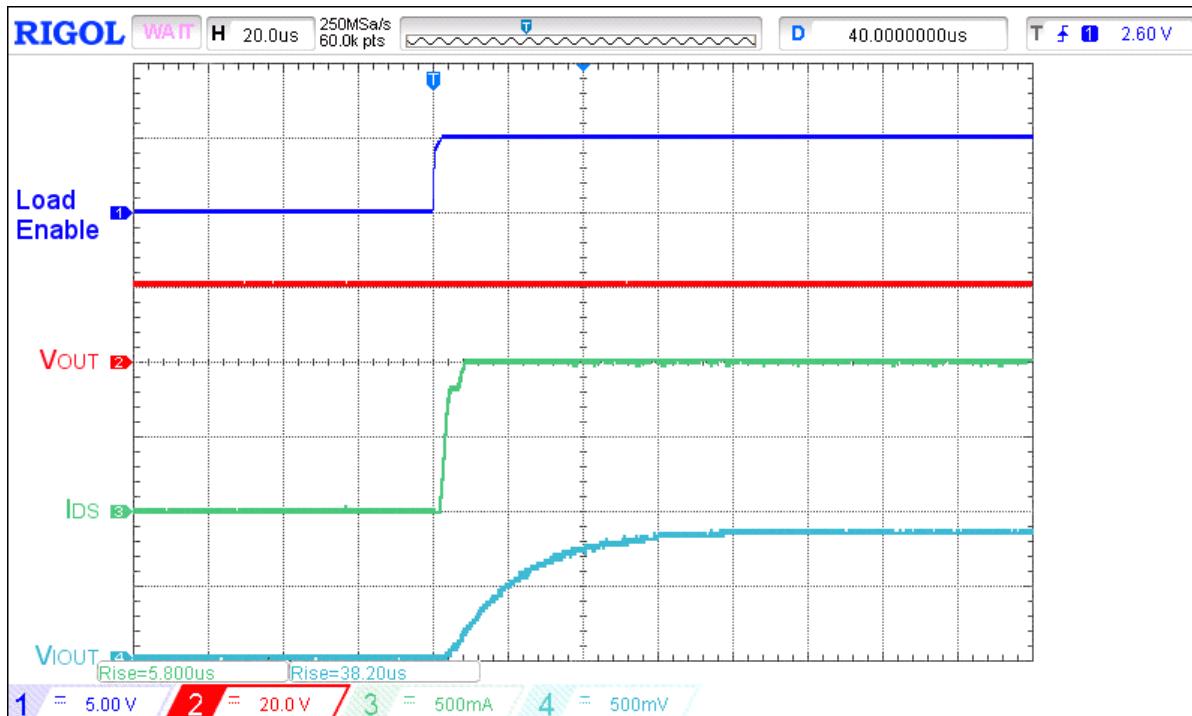


Figure 37. Typical I_{OUT} response time waveform for $V_{IN} = 20$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 20$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 0 A to 1 A

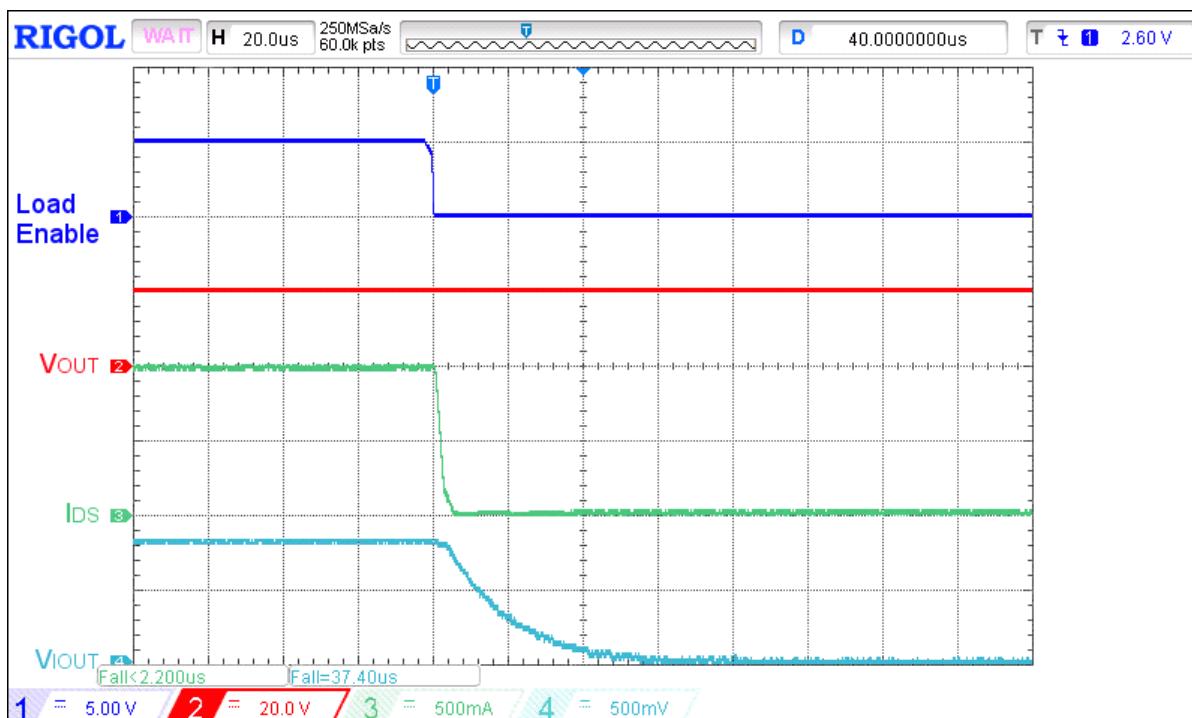


Figure 38. Typical I_{OUT} response time waveform for $V_{IN} = 20$ V, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 20$ Ω , $C_{IOUT} = 0.18$ nF, $R_{IOUT} = 84.5$ k Ω , load step 1 A to 0 A

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Typical SOA Waveforms

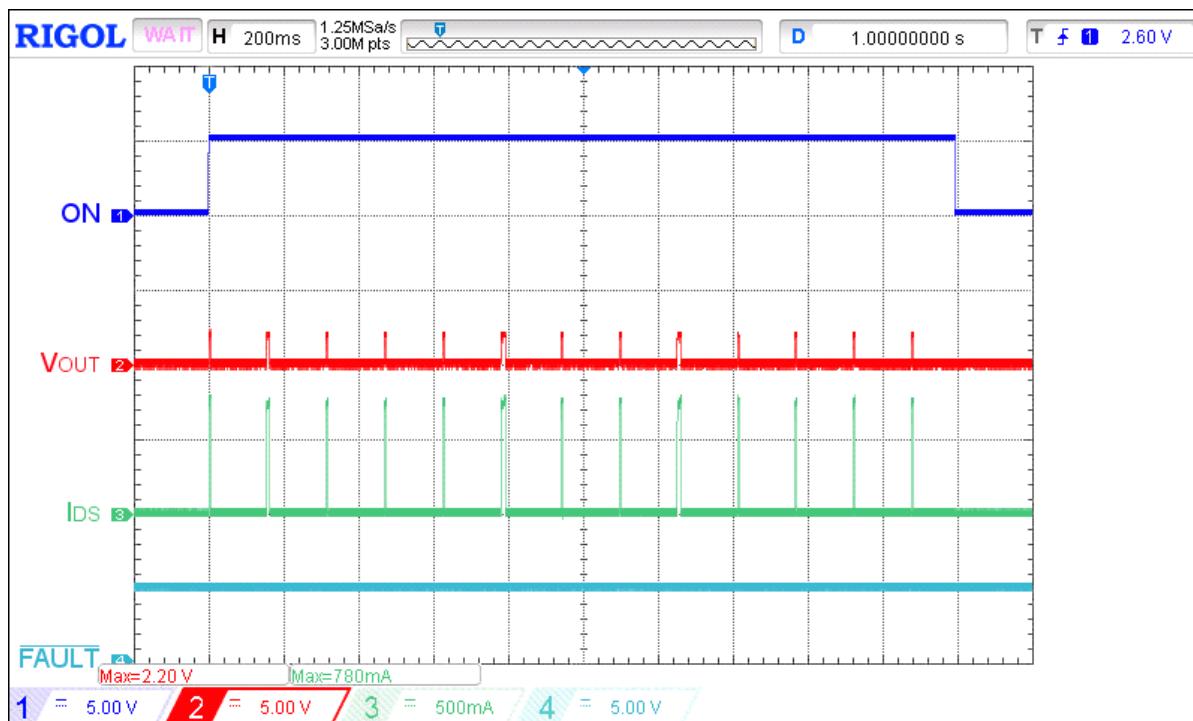


Figure 39. Typical SOA waveform during power up under heavy load for $V_{IN} = 9$ V,
 $C_{LOAD} = 10 \mu F$, $R_{SET} = 30.1 \text{ k}\Omega$, $R_{LOAD} = 3.8 \Omega$

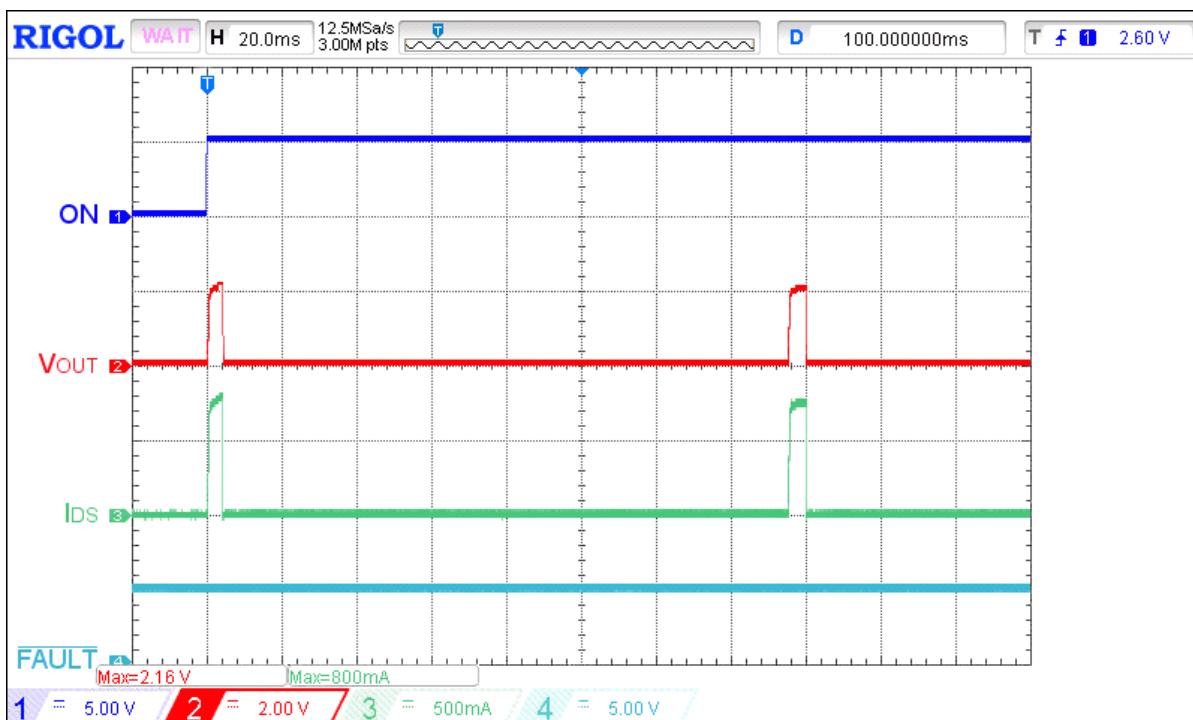


Figure 40. Extended typical SOA waveform during power up under heavy load for $V_{IN} = 9$ V,
 $C_{LOAD} = 10 \mu F$, $R_{SET} = 30.1 \text{ k}\Omega$, $R_{LOAD} = 3.8 \Omega$

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

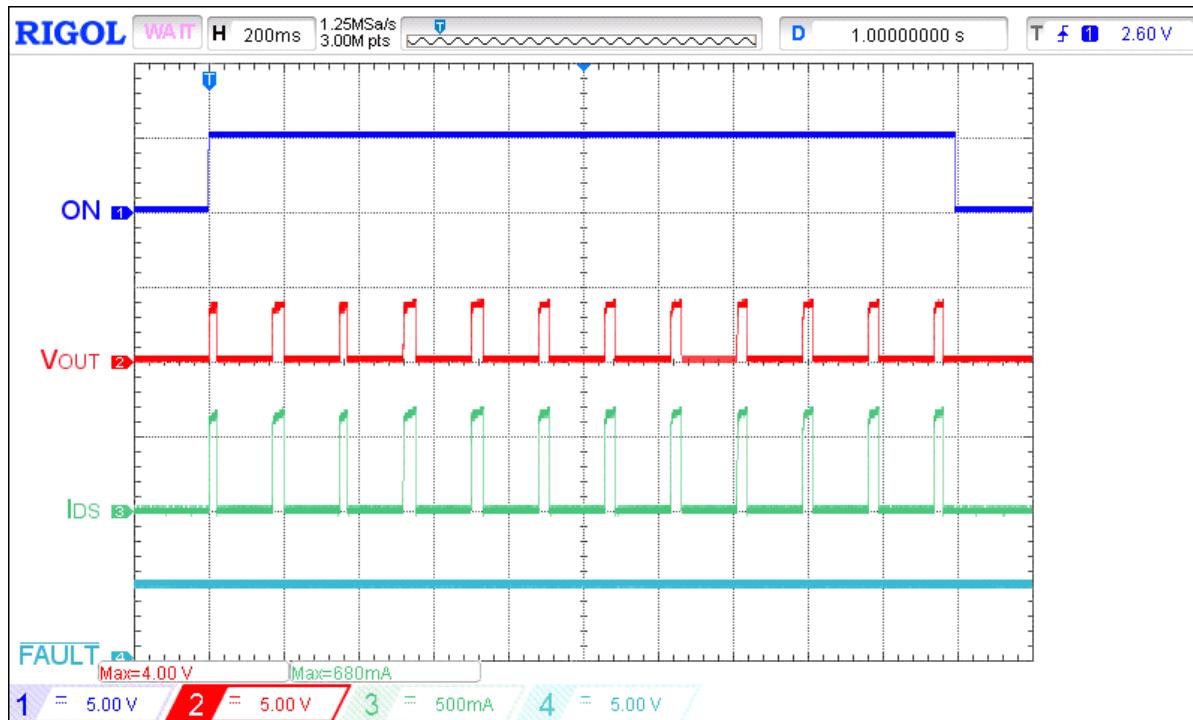


Figure 41. Typical SOA waveform during power up under heavy load for V_{IN} = 12 V,
C_{LOAD} = 10 µF, R_{SET} = 30.1 kΩ, R_{LOAD} = 5 Ω

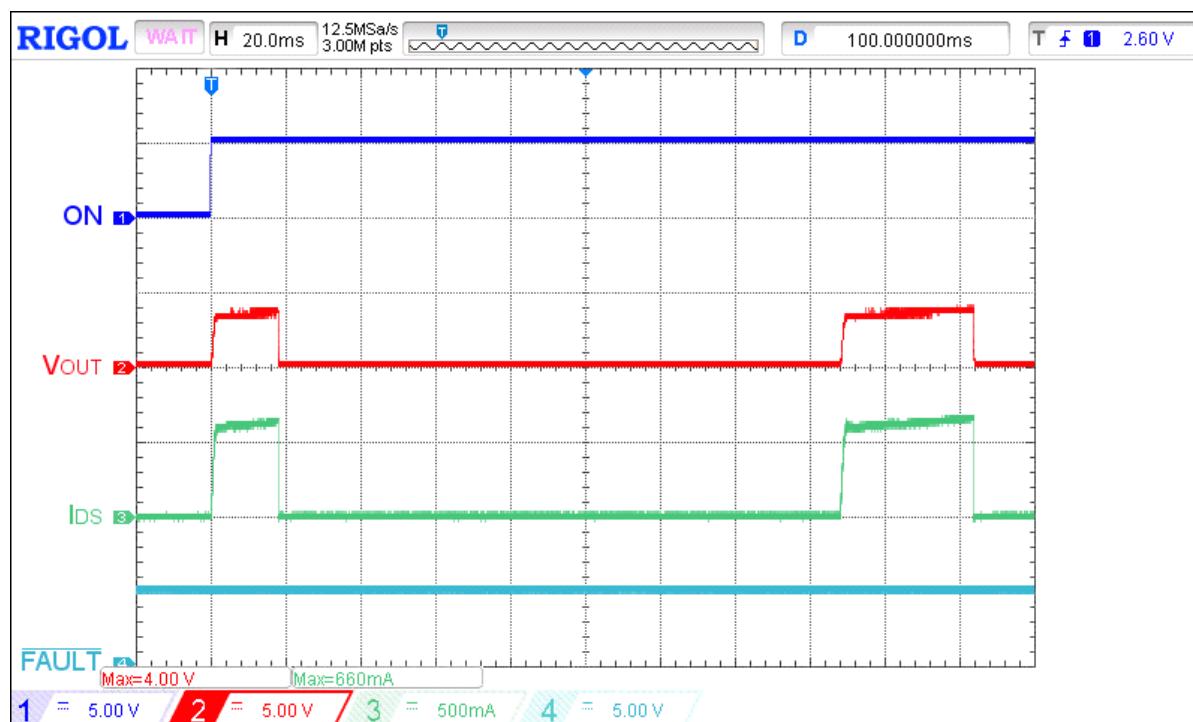


Figure 42. Extended typical SOA waveform during power up under heavy load for V_{IN} = 12 V,
C_{LOAD} = 10 µF, R_{SET} = 30.1 kΩ, R_{LOAD} = 5 Ω

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A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

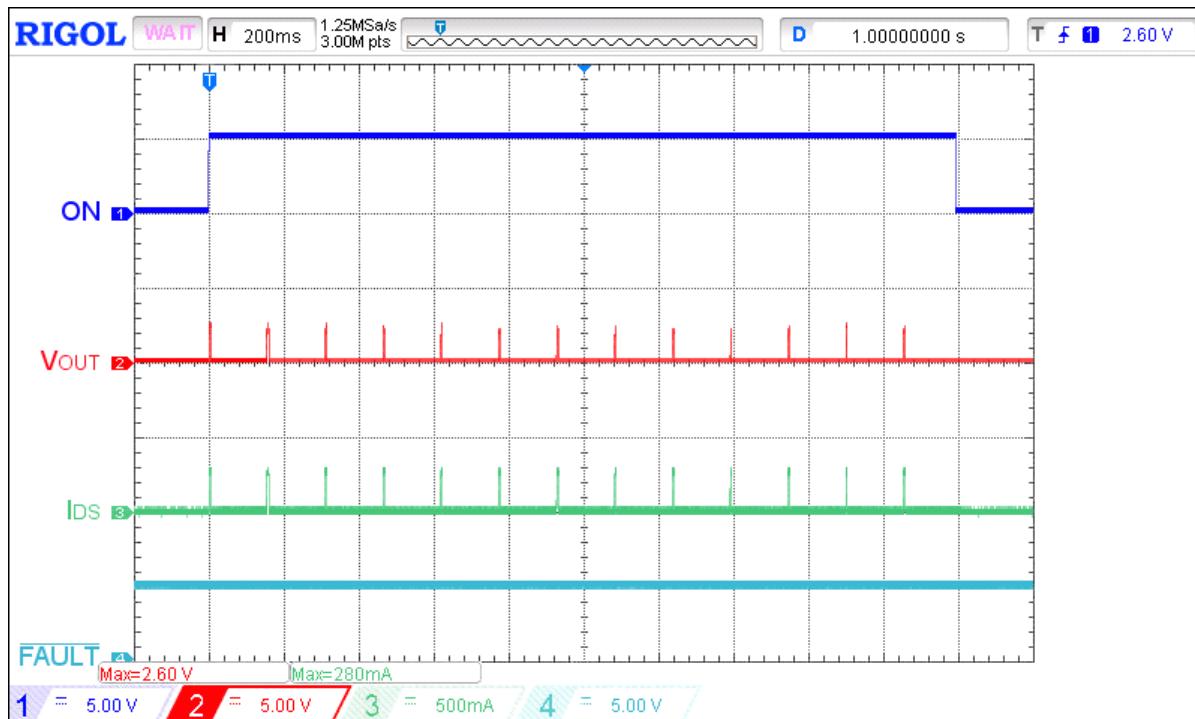


Figure 43. Typical SOA waveform during power up under heavy load for V_{IN} = 20 V,
C_{LOAD} = 10 µF, R_{SET} = 30.1 kΩ, R_{LOAD} = 8 Ω

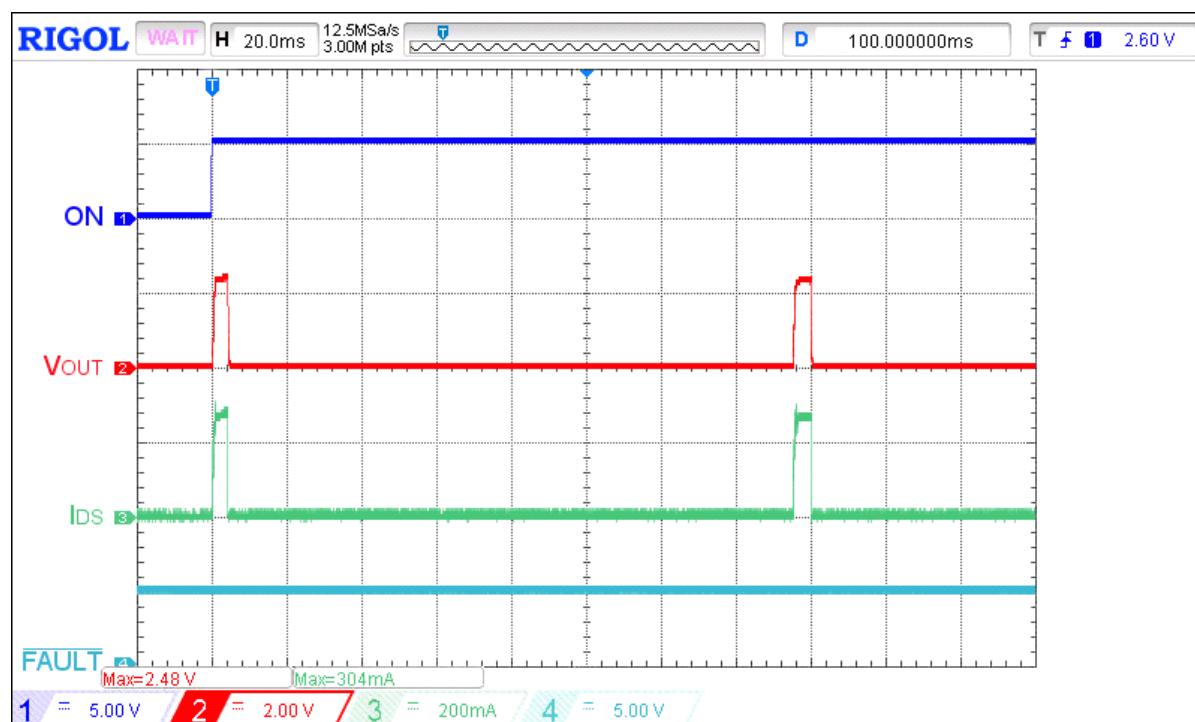


Figure 44. Extended typical SOA waveform during power up under heavy load for V_{IN} = 20 V,
C_{LOAD} = 10 µF, R_{SET} = 30.1 kΩ, R_{LOAD} = 8 Ω

Applications Information

High Voltage GreenFET Safe Operating Area Explained

Renesas's High Voltage GreenFET load switches incorporate a number of internal protection features that prevents them from damaging themselves or any other circuit or subcircuit downstream of them. One particular protection feature is their Safe Operation Area (SOA) protection. SOA protection is automatically activated under overpower and, in some cases, under overcurrent conditions. Overpower SOA is activated if package power dissipation exceeds an internal 5 W threshold longer than 2.5 ms. High Voltage GreenFET devices will quickly switch off (open circuit) upon overpower detection and automatically resume (close) nominal operation once overpower condition no longer exists.

One possible way to have an overpower condition trigger SOA protection is when High Voltage GreenFET products are enabled into heavy output resistive loads and/or into large load capacitors. It is under these conditions to follow carefully the "Safe Start-up Loading" guidance in the Applications section of the datasheet. During an overcurrent condition, High Voltage GreenFET devices will try to limit the output current to the level set by the external R_{SET} resistor. Limiting the output current, however, causes an increased voltage drop across the FET's channel because the FET's RDS_{ON} increased as well. Since the FET's RDS_{ON} is larger, package power dissipation also increases. If the resultant increase in package power dissipation is higher/equal than 5 W for longer than 2.5 ms, internal SOA protection will be triggered and the FET will open circuit (switch off). Every time SOA protection is triggered, all High Voltage GreenFET devices will automatically attempt to resume nominal operation after 160 ms.

Safe Start-up Condition

SLG59H1020V has built-in protection to prevent over-heating during start-up into a heavy load. Overloading the V_{OUT} pin with a capacitor and a resistor may result in non-monotonic V_{OUT} ramping. In general, under light loading on V_{OUT}, V_{OUT} ramping can be controlled with C_{SLEW} value. The following equation serves as a guide:

$$C_{SLEW} = \frac{T_{RISE}}{V_{IN}} \times 4.9 \mu\text{A} \times \frac{20}{3}$$

where

T_{RISE} = Total rise time from 10% V_{OUT} to 90% V_{OUT}

V_{IN} = Input Voltage

C_{SLEW} = Capacitor value for CAP pin

When capacitor and resistor loading on V_{OUT} during start up, the following tables will ensure V_{OUT} ramping is monotonic without triggering internal protection:

Safe Start-up Loading for V _{IN} = 12 V (Monotonic Ramp)			
Slew Rate (V/ms)	C _{SLEW} (nF) ²	C _{LOAD} (μF)	R _{LOAD} (Ω)
1	33.3	500	20
2	16.7	250	20
3	11.1	160	20
4	8.3	120	20
5	6.7	100	20

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Safe Start-up Loading for $V_{IN} = 22$ V (Monotonic Ramp)			
Slew Rate (V/ms)	C_{SLEW} (nF) ²	C_{LOAD} (μF)	R_{LOAD} (Ω)
0.5	66.7	500	80
1.0	33.3	250	80
1.5	22.2	160	80
2.0	16.7	120	80
2.5	13.3	100	80

Note 2: Select the closest-value tolerance capacitor.

Setting the SLG59H1020V's Active Current Limit

R_{SET} (kΩ)	Active Current Limit (A) ³
91	1
45	2
30	3

Note 3: Active Current Limit accuracy is ±15% over voltage range and over temperature range.

Setting the SLG59H1020V's Input Overvoltage Lockout Threshold

As shown in the table below, SEL[1,0] selects the V_{IN} overvoltage threshold at which the SLG59H1020V's internal state machine will turn OFF (open circuit) the power MOSFET if V_{IN} exceeds the selected threshold.

SEL1	SEL0	$V_{IN(OVLO)}$ (Typ)
0	0	6.0
0	1	10.8
1	0	17.0
1	1	22.0

For example, SEL[1,1] would be the most appropriate setting for applications where the steady-state V_{IN} can extend up to 20 V without causing any damage to the SLG59H1020V since the IC is 29-V tolerant.

With an activated SLG59H1020V (ON=HIGH) and at any time V_{IN} crosses the programmed V_{IN} overvoltage threshold, the state machine opens the load switch and asserts the \overline{FAULT} pin within T_{FAULT_LOW} .

In applications with a deactivated or inactive SLG59H1020V ($V_{IN} > V_{IN(OVLO)}$ and ON=LOW) and if the applied V_{IN} is higher than the programmed $V_{IN(OVLO)}$ threshold, the SLG59H1020V's state machine will keep the load switch open circuited if the ON pin is toggled LOW-to-HIGH. In these cases, the \overline{FAULT} pin will also be asserted within T_{FAULT_LOW} and will remain asserted until V_{IN} resumes nominal, steady-state operation.

In all cases, the SLG59H1020V's V_{IN} undervoltage lockout threshold is fixed at $V_{IN(UVLO)}$.

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Power Dissipation

The junction temperature of the SLG59H1020V depends on different factors such as board layout, ambient temperature, and other environmental factors. The primary contributor to the increase in the junction temperature of the SLG59H1020V is the power dissipation of its power MOSFET. Its power dissipation and the junction temperature in nominal operating mode can be calculated using the following equations:

$$PD = RDS_{ON} \times I_{DS}^2$$

where:

PD = Power dissipation, in Watts (W)

R_{DS}_{ON} = Power MOSFET ON resistance, in Ohms (Ω)

I_{DS} = Output current, in Amps (A)

and

$$T_J = PD \times \theta_{JA} + T_A$$

where:

T_J = Junction temperature, in Celsius degrees (°C)

θ_{JA} = Package thermal resistance, in Celsius degrees per Watt (°C/W)

T_A = Ambient temperature, in Celsius degrees (°C)

In current-limit mode, the SLG59H1020V's power dissipation can be calculated by taking into account the voltage drop across the load switch (V_{IN}-V_{OUT}) and the magnitude of the output current in current-limit mode (I_{ACL}):

$$PD = (V_{IN} - V_{OUT}) \times I_{ACL} \text{ or}$$

$$PD = (V_{IN} - (R_{LOAD} \times I_{ACL})) \times I_{ACL}$$

where:

PD = Power dissipation, in Watts (W)

V_{IN} = Input Voltage, in Volts (V)

R_{LOAD} = Load Resistance, in Ohms (Ω)

I_{ACL} = Output limited current, in Amps (A)

V_{OUT} = R_{LOAD} × I_{ACL}

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Layout Guidelines:

1. Since the VIN and VOUT pins dissipate most of the heat generated during high-load current operation, it is highly recommended to make power traces as short, direct, and wide as possible. A good practice is to make power traces with absolute minimum widths of 15 mils (0.381 mm) per Ampere. A representative layout, shown in [Figure 45](#), illustrates proper techniques for heat to transfer as efficiently as possible out of the device;
2. To minimize the effects of parasitic trace inductance on normal operation, it is recommended to connect input C_{IN} and output C_{LOAD} low-ESR capacitors as close as possible to the SLG59H1020V's VIN and VOUT pins;
3. The GND pin should be connected to system analog or power ground plane.
4. 2 oz. copper is recommended for high current operation.

SLG59H1020V Evaluation Board:

A High Voltage GreenFET Evaluation Board for SLG59H1020V is designed according to the statements above and is illustrated on [Figure 45](#). Please note that evaluation board has D_Sense and S_Sense pads. They cannot carry high currents and dedicated only for RDS_{ON} evaluation.

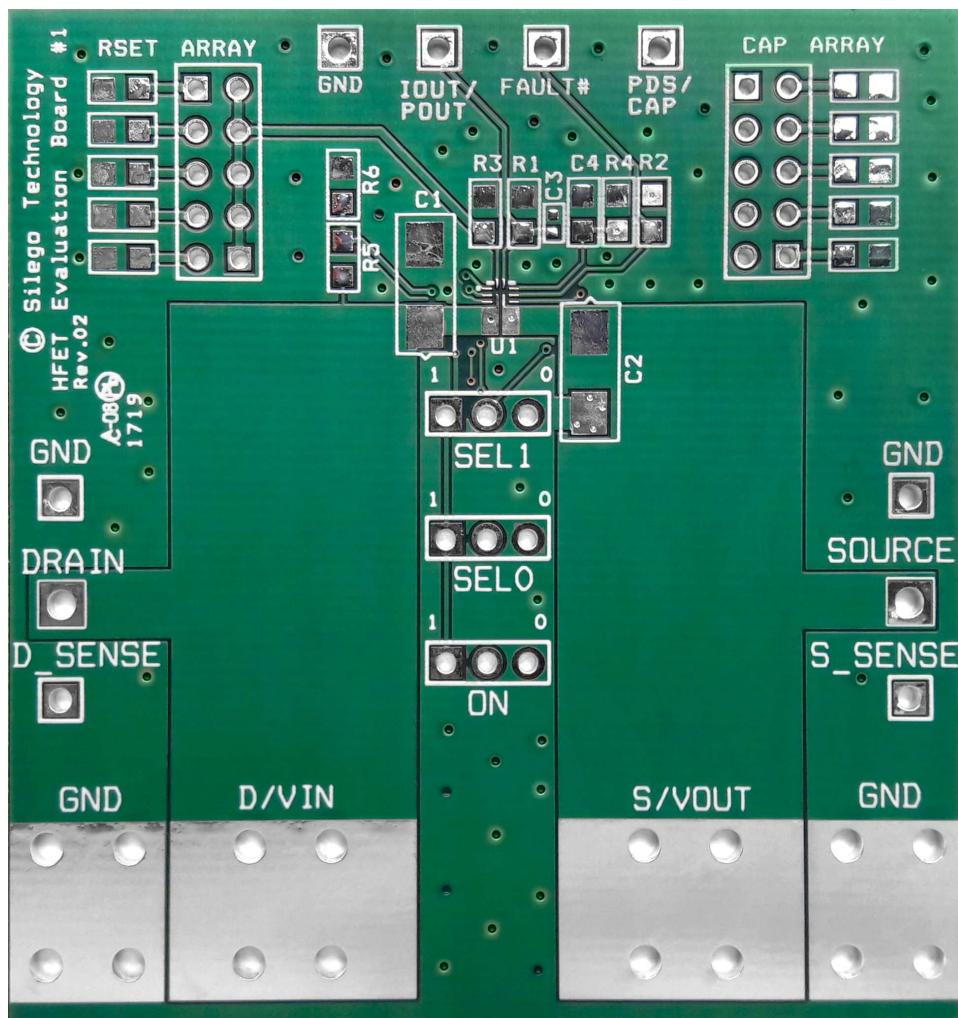


Figure 45. SLG59H1020V Evaluation Board

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

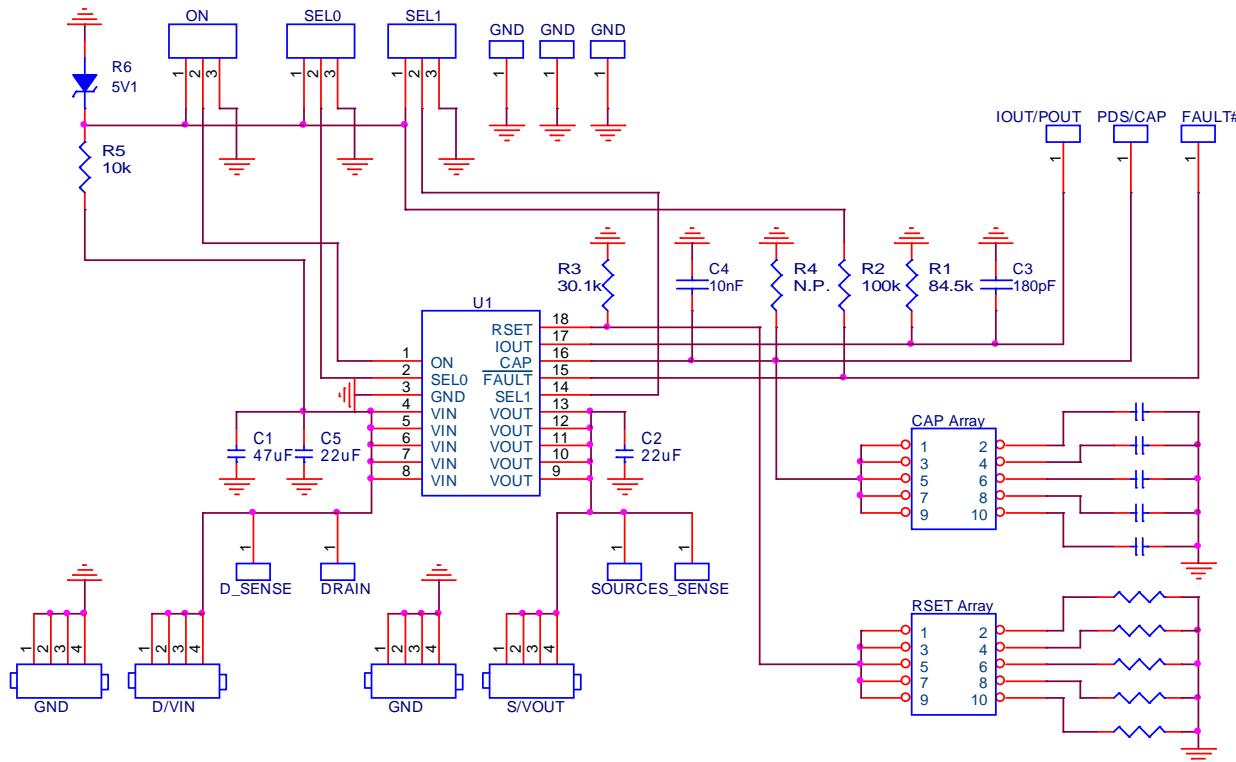


Figure 46. SLG59H1020V Evaluation Board Connection Circuit

Basic Test Setup and Connections

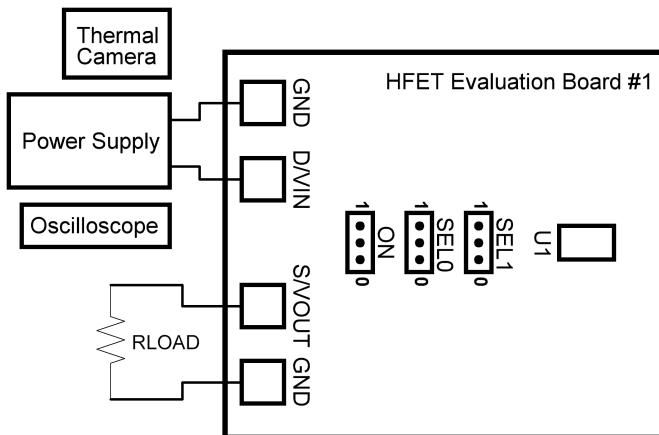


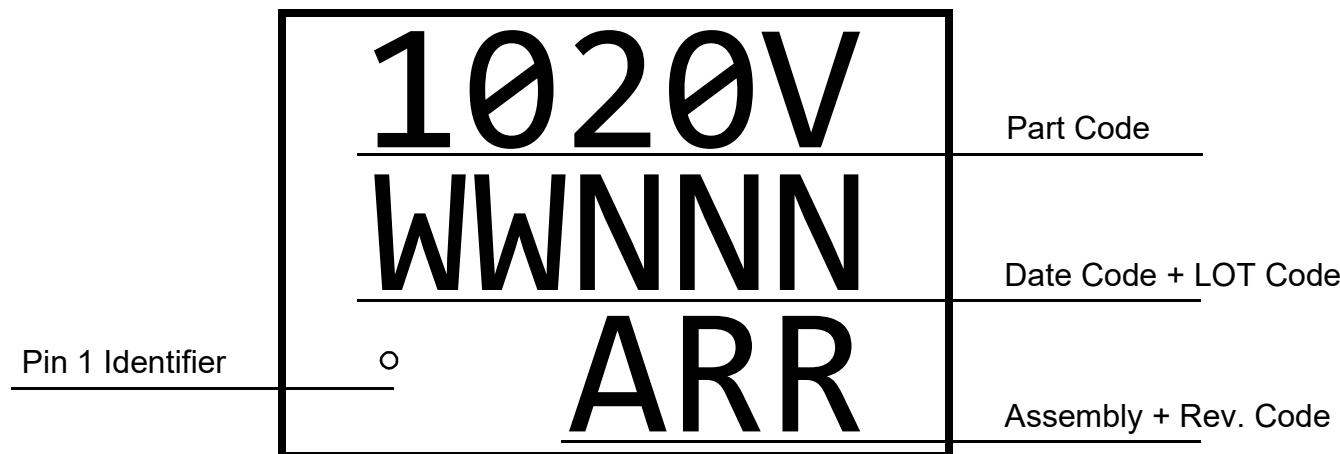
Figure 47. SLG59H1020V Evaluation Board Connection Circuit

EVB Configuration

1. Based on V_{IN} voltage, set SEL0, SEL1 to GND or 5 V to configure OVLO;
2. Connect oscilloscope probes to D/VIN, S/VOUT, ON, etc.;
3. Turn on Power Supply and set desired V_{IN} from 4.5 V...20 V range;
4. Toggle the ON signal High or Low to observe SLG59H1020V operation.

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Package Top Marking System Definition



1020V - Part ID Field

WW - Date Code Field¹

NNN - Lot Traceability Code Field¹

A - Assembly Site Code Field²

RR - Part Revision Code Field²

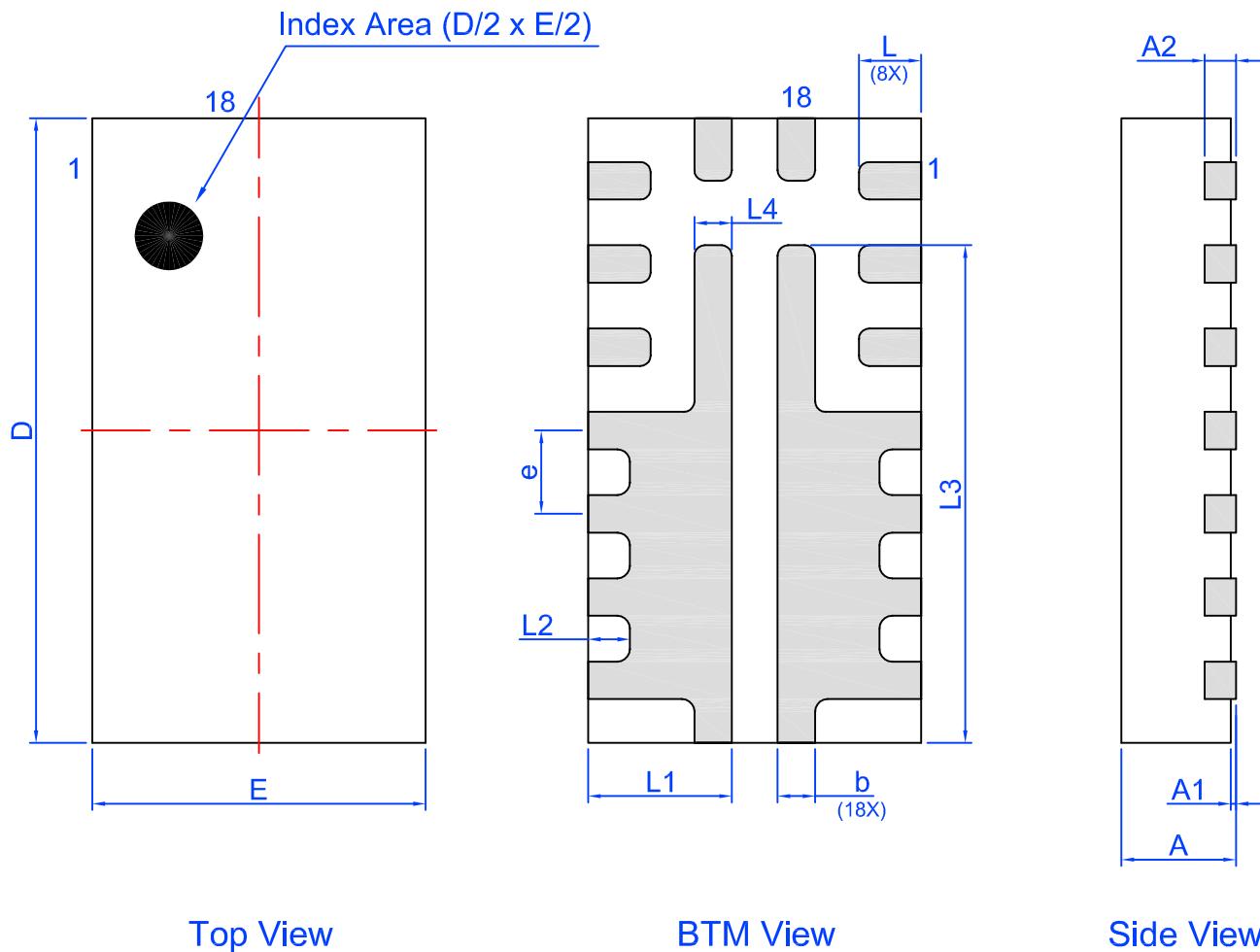
Note 1: Each character in code field can be alphanumeric A-Z and 0-9

Note 2: Character in code field can be alphabetic A-Z

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Package Drawing and Dimensions

18 Lead TQFN Package 1.6 x 3 mm (Fused Lead)
JEDEC MO-220, Variation WCEE

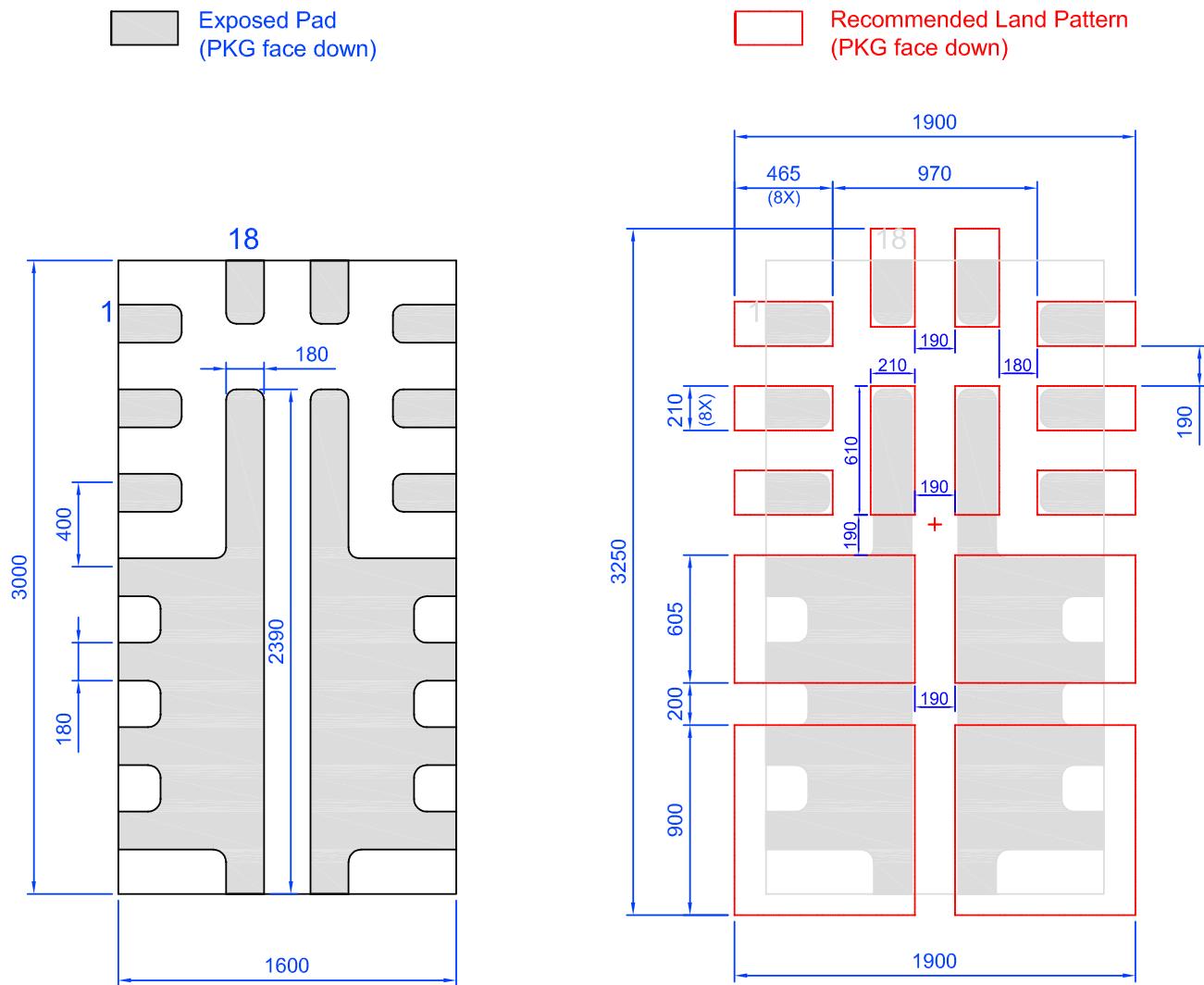


Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	2.95	3.00	3.05
A1	0.005	-	0.05	E	1.55	1.60	1.65
A2	0.10	0.15	0.20	L	0.25	0.30	0.35
b	0.13	0.18	0.23	L1	0.64	0.69	0.74
e	0.40 BSC			L2	0.15	0.20	0.25
L3	2.34	2.39	2.44	L4	0.13	0.18	0.23

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

SLG59H1020V 18-pin STQFN PCB Landing Pattern

Note: All dimensions shown in micrometers (µm)

SLG59H1020V

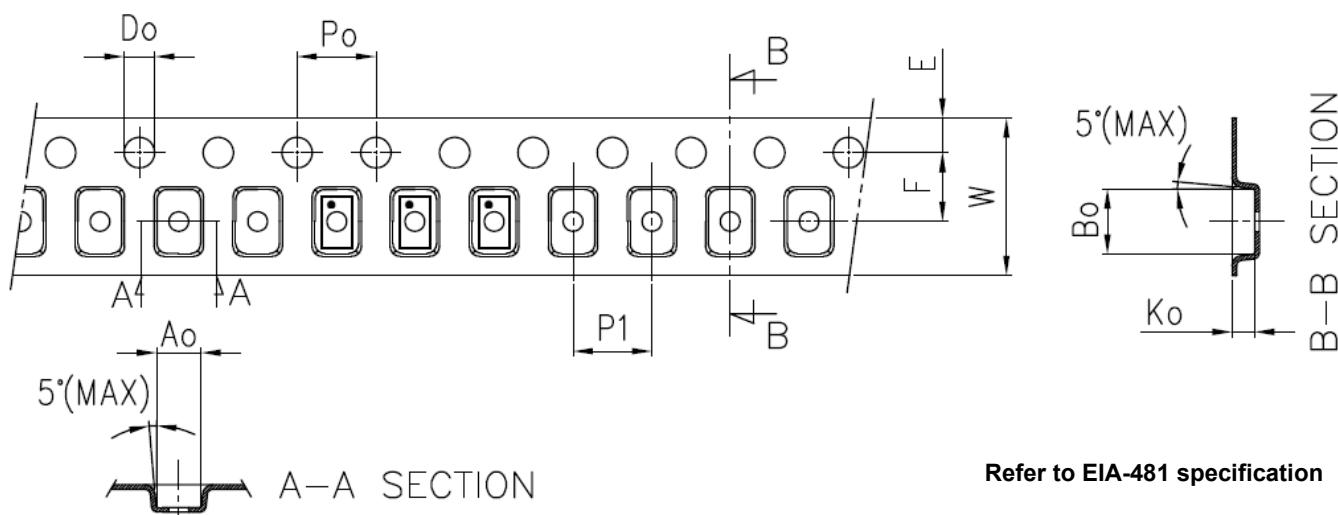
A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
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Tape and Reel Specifications

Package Type	# of Pins	Nominal Package Size [mm]	Max Units		Reel & Hub Size [mm]	Leader (min)		Trailer (min)		Tape Width [mm]	Part Pitch [mm]
			per Reel	per Box		Pockets	Length [mm]	Pockets	Length [mm]		
STQFN 18L 1.6x3mm 0.4P FC Green	18	1.6 x 3 x 0.55	3,000	3,000	178 / 60	100	400	100	400	8	4

Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length	Pocket BTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge	Index Hole to Pocket Center	Tape Width
	A0	B0	K0	P0	P1	D0	E	F	W
STQFN 18L 1.6x3mm 0.4P FC Green	1.78	3.18	0.76	4	4	1.5	1.75	3.5	8



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 2.64 mm³ (nominal). More information can be found at www.jedec.org.

SLG59H1020V

A 20 V, 50 mΩ, 3 A, Reverse Blocking Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Revision History

Date	Version	Change
2/2/2022	1.03	Updated Company name and logo Added SOA Protection Threshold to Features Fixed typos Updated EVB image
12/20/2018	1.01	Updated style and formatting Updated Charts Added Layout Guidelines Fixed typos
10/19/2017	1.00	Production Release

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